WD76C20/LV Floppy Disk Controller, Real Time Clock, IDE Interface, and Support Logic Device

WESTERN DIGITAL



TABLE OF CONTENTS

| Section | Title | | | | | | | | | | | | | | | | | | | | Page |
|---------|-------------|-----------------------|-------------------|--------|------|------|------|------|---|---|-------|---|------|---|---|---|---|---|-----|-----|------------------|
| 1.0 | 1.1 | DUCTION Documen | | | | ••• | • | | | • | | | | | | | • | | • | • | . 5-1 . 5-1 |
| | 1.2 | Features | | | · | | • | | · | · | • • | • | | • | • | • | • | • | • | • | . 5-1 |
| | 1.3 | General E | Description | ۱ | · | • • | · | | · | • | • • | • | • • | ٠ | · | · | · | · | • | • | . 5-3 |
| 2.0 | ARCF 2.1 | ITECTUR Bus Interf | E ace Logic | | | | • | | • | | | • | | • | • | | • | • | • | • • | . 5-4 . 5-5 |
| | 2.2 | Chip Sele | 0 | | | · · | · | · · | • | • | | | | | | | | | | | . 5-5 |
| | 2.3 | • | sk Control | | | | | | | | | | | | | | | | | | . 5-5 |
| | 2.4 | | e Clock an | | М | | | | | | | | | | | | | | | | . 5-5 |
| | 2.5 | Suspend/ | Resume L | .ogic | | | | | | | | | | | | | | | | | . 5-5 |
| 3.0 | SIGN | AL DESCF | RIPTION | | | | | | | | • • • | | | | | | | | • | • | . 5-6 |
| 4.0 | CHIP | SELECT L | OGIC | | | | • | | | | | | | • | | | | | • | | . 5-15 |
| 5.0 | FLOP | PY DISK (| CONTROL | LER | | | • | | • | • | | • | | | | • | • | • | • | | . 5-18 |
| | 5.1 | | npatible C | | • | | | | | • | | • | | | · | • | • | • | • | | . 5-18 |
| | | | Clock and | - | | nera | ator | • | • | • | • • | • | • • | • | • | • | • | • | • | | . 5-18 |
| | | | 5.1.1.1 | SCLK | | | · | | • | • | • • | · | | · | · | · | · | • | • | • • | 5-18 |
| | | | 5.1.1.2 | WCLI | | | • | | · | • | • • | • | | • | · | · | • | • | • | • • | 5-19 |
| | | | 5.1.1.3 | MCL | - | | · | | · | • | • • | · | • • | • | · | · | • | • | • | • • | 5-19 |
| | | | 5.1.1.4 | Auton | | | | | | | ode | | • • | · | · | · | • | • | • | | . 5-19 |
| | 5.2 | Drive Inte | | | | | | | | | • • | · | • • | | · | · | · | • | • • | • • | 5-19 |
| | | | Data Sepa | | | | | | | | | · | • • | · | · | · | · | • | • | • • | . 5-20 . 5-20 |
| | 5.3 | 5.2.2 N Host Inter | Nrite Prec | • | | | | | | | | · | • • | · | · | • | · | • | • • | • • | 5-20 |
| | 5.5 | | Control Re | | | | | | • | · | • • | · | • • | · | · | • | · | • | • • | • • | 5-20 |
| | | | Disk Interfa | - | | | | | • | : | ••• | · | • • | · | · | · | · | • | • • | • • | 5-22 |
| | | | Disk internations | | | | - | | | | · · | · | • • | • | • | • | • | • | • • | ••• | 5-22 |
| | | | Master Sta | • | | | | | | | · · | | | | | | | | ••• | | 5-23 |
| | | | 5.3.4.1 | MSR | 0 | | | | | | | | | | | | | | | | 5-23 |
| | | 5 | 5.3.4.2 | MSR: | | | | | | | | | ••• | | | | | | | | 5-24 |
| | | 5 | 5.3.4.3 | Overr | | | | | | | | 1 | | | | | | | | | 5-25 |
| | | 5.3.5 \$ | Status Rec | | | | | | | • | | | | | | | | | | | 5-26 |
| | | 5 | 5.3.5.1 | Status | s Re | gist | er (|) | | | | | | | | | | | | | 5-26 |
| | | 5 | 5.3.5.2 | Status | | | | | | | | | | | | | | | | | 5-26 |
| | | 5 | 5.3.5.3 | Status | s Re | gist | er 2 | 2 | | | | | | | | | | | | | 5-27 |
| | | 5 | 5.3.5.4 | Status | s Re | gist | er 3 | 3 | | | | | | | | | | | • • | | 5-28 |
| | | 5.3.6 [| Data Regis | ster | | • | • | | | | | | | | | • | • | • | | | 5-29 |

WD76C20/LV

| Section | Title Page |
|-------------|---|
| 6.0 | IDE DRIVE INTERFACE 5-30 6.1 IDE Drive Signal Logic 5-30 6.2 Chip Select 5-30 6.3 IDE/FDD Drive Selection 5-30 6.4 IDE Read/Write 5-30 6.5 IDE Drive Select 5-30 6.6 Data Path Select 5-30 |
| 7.0 | REAL TIME CLOCK 5-31 7.1 Time Base Oscillator Circuit 5-32 7.2 Power Switch 5-32 7.3 Bus Interface 5-32 7.4 Clock Divider 5-32 7.5 Periodic Interrupt 5-32 |
| | 7.6 BCD/Binary Increment & Clock/Calendar Update 5-33 7.7 Operational Registers 5-33 7.7.1 Setting Correct Time 5-33 7.7.2 Setting Alarm Intervals 5-34 7.7.3 RTC Register A 5-34 7.7.4 RTC Register B 5-35 7.7.5 RTC Register C 5-36 7.7.6 RTC Register D 5-37 |
| 8.0 | POWER MANAGEMENT: SUSPEND/RESUME LOGIC 5-38 8.1 Overview 5-38 8.1.1 Suspending the System 5-38 8.1.2 Resuming the System 5-39 8.2 PDREF 5-42 8.3 14 MHZ Crystal Specifications 5-42 8.4 Pin States During Power Down 5-43 |
| 9.0 | SPECIFICATIONS 5-46 9.1 Maximum Ratings 5-46 9.2 DC Operating Characteristics 5-46 9.3 Crystal Capacitance 5-47 |
| 10.0 | AC OPERATING CHARACTERISTICS5-4810.1Floppy Disk Controller Specifications5-4810.2Real Time Clock Specifications5-5610.3IDE Interface Timing5-6210.4Suspend/Resume Timing5-66 |
| 11.0 A.0 | PACKAGE DIMENSIONS 5-70 WD76C20LV DEVICE SPECIFICATIONS 5-72 |

1

LIST OF TABLES

| Table | Title | Page |
|-------|---|------|
| 3-1 | Pin Assignments (Alphabetical Order) | 5-7 |
| 3-2 | Pin Assignments (Numerical Order) | 5-7 |
| 3-3 | Signal Descriptions | 5-8 |
| 4-1 | Chip Select Line Decoder | 5-16 |
| 4-2 | I/O Address and Chip Select Assignments | 5-17 |
| 5-1 | FDC Sampling (SCLK) Clock | 5-18 |
| 5-2 | FDC MCLK & WCLK Generation | 5-19 |
| 5-3 | FDC Register Map | 5-21 |
| 5-4 | FCLK1 Data Rate Decoder | 5-22 |
| 5-5 | Drive Select Decode | 5-23 |
| 5-6 | MSR/DDR Decode | 5-23 |
| 5-7 | PS/2 Support Sequence | 5-24 |
| 5-8 | Data Register Decode | 5-29 |
| 6-1 | IDE Chip Select Assignments | 5-30 |
| 7-1 | RTC Data Modes | 5-34 |
| 7-2 | RTC Periodic Interrupt Rate Decoder | 5-35 |
| 8-1 | Pin States During Power-Down | 5-43 |
| 9-1 | DC Characteristics | 5-46 |
| 9-2 | Crystal Capacitance | 5-47 |
| 10-1 | FDC Read Timing Specification | 5-48 |
| 10-2 | FDC Read w/ Bale Timing Specification | 5-49 |
| 10-3 | FDC Write Timing Specification | 5-50 |
| 10-4 | FDC Write w/Bale Timing Specification | 5-51 |
| 10-5 | FDC DMA Timing Specification | 5-52 |
| 10-6 | FDC Terminal Count Timing Specification | 5-53 |
| 10-7 | FDC 16 MHz Clock Timing Specification | 5-54 |
| 10-8 | FDC Disk Drive Timing Specification | 5-55 |
| 10-9 | RTC and RAM Read Timing Specification | 5-56 |
| 10-10 | RTC and RAM Write w/Bale Timing Specification | 5-57 |
| 10-11 | RTC and Ram Write Timing Specification | 5-58 |
| 10-12 | RTC and RAM Read w/Bale Timing Specification | 5-59 |
| 10-13 | RTCIRQ Release Timing Specification | 5-60 |
| 10-14 | Reset Timing Specification | 5-61 |
| 10-15 | IDE Interface Timing (IDED7 TO DB7) | 5-62 |
| 10-16 | IDE Interface w/Bale Timing (IDED7 TO DB7) | 5-63 |
| 10-17 | IDE Interface Timing (DB7 TO IDED7) | 5-64 |
| 10-18 | IDE Interface w/Bale Timing (DB7 TO IDED7) | 5-65 |
| 10-19 | Resume to Suspend Support Timing | 5-66 |
| 10-20 | Suspend to Resume Support Timing | 5-67 |
| 10-21 | Chip Select Logic Decode Timing | 5-68 |

5

| 10-22 | Chip Select Logic Decode w/Bale Timi | ng | | • | | • | | | | | | | | | | • | | • | | 5-69 |
|-------|--------------------------------------|----|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|----|---|------|
| A-1 | D.C. Characteristics (WD76C20LV) | • | • | | | | • | | | | | | | | | • | | | • | 5-72 |
| A-2 | Crystal Capacitance for WD76C20LV | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • | ۰. | • | 5-74 |

LIST OF ILLUSTRATIONS

| Figure | Title F | Page |
|--------|---|------|
| 1-1 | System Level Functional Block Diagram | 5-2 |
| 2-1 | WD76C20 Functional Block Diagram | 5-4 |
| 3-1 | WD76C20 Pin Diagram | 5-6 |
| 4-1 | Chip Select Block Diagram | 5-15 |
| 5-1 | 16 MHz Crystal | 5-18 |
| 7-1 | RTC Block Diagram | 5-31 |
| 7-2 | VBAT External Support | 5-32 |
| 7-3 | RTC Crystal External Circuitry | 5-32 |
| 7-4 | RTC Crystal Parameters | 5-32 |
| 7-5 | RTC Address Map | 5-33 |
| 8-1 | Suspend/Resume/Sleep Mode Cycle | 5-40 |
| 8-2 | Full Power Down-Mode System Block Diagram | 5-41 |
| 8-3 | | 5-42 |
| 10-1 | FDC Read Timing Diagram | 5-48 |
| 10-2 | FDC Read w/Bale Timing Diagram | 5-49 |
| 10-3 | FDC Write Timing Diagram | |
| 10-4 | FDC Write w/Bale Timing Diagram | |
| 10-5 | FDC DMA Timing Diagram | |
| 10-6 | FDC Terminal Count Timing Diagram | |
| 10-7 | | 5-54 |
| 10-8 | | 5-55 |
| 10-9 | RTC and RAM Read Timing Diagram | 5-56 |
| 10-10 | RTC and RAM Read w/Bale Timing Diagram | 5-57 |
| 10-11 | | 5-58 |
| 10-12 | RTC and RAM Read w/Bale Timing Diagram | 5-59 |
| 10-13 | RTC IRQ Release Timing Diagram | 5-60 |
| 10-14 | Reset Timing Diagram | 5-61 |
| 10-15 | IDE Interface Timing Diagram (IDED7 TO DB7) | 5-62 |
| 10-16 | IDE Interface w/Bale Timing (IDED7 TO DB7) | 5-63 |
| 10-17 | IDE Interface Timing (DB7 TO IDED7) | 5-64 |
| 10-18 | IDE Interface w/Bale Timing (DB7 TO IDED7) | 5-65 |
| 10-19 | Resume To Suspend Support Timing | 5-66 |
| 10-20 | | 5-67 |
| 10-21 | | 5-68 |
| 10-22 | Chip Select Logic w/Bale Timing | 5-69 |
| 11-1 | WD76C20 Package Diagram (84-Pin PLCC) | 5-70 |
| 11-2 | | 5-71 |
| A-1 | | 5-73 |
| A-2 | | 5-73 |
| A-3 | | 5-73 |

5

1.0 INTRODUCTION

1.1 DOCUMENT SCOPE

This data sheet applies to both the WD76C20, and WD76C20LV. The WD90C20LV is a low voltage version of the WD76C20 chip. For convenience all references to these two devices will be referred to as the WD76C20.

See Appendix A for the specification differences of the WD76C20LV.

1.2 FEATURES

The WD76C20 includes these features:

- 84-pin PLCC and PQFP packages
- 5V supply requirement (WD76C20)
 3.3V supply requirement (WD76C20LV)
- 3.0V battery backup supply for the RTC and 114 byte SRAM (WD76C20)
 2.4V battery backup supply for the RTC and 114 byte SRAM (WD76C20LV)
- Implemented in a low-power, high-performance, 1.25 micron CMOS technology process
- Floppy Disk Controller (FDC) software transparent power-down mode with low standby ICC current. FDC features:
 - · 256 tracks support
 - 100% software compatible with NEC 765A
 - Integrated high-performance DPLL data separator:
 - 125, 250, 300, 500 Kb/sec and 1 Mb/sec data rates
 - Option to select 150 Kb/sec FM and 300 Kb/sec MFM data rates only
 - Automatic Write Precompensation:
 - Defeat option
 - Inner track value of 125 or 187 ns pin selectable

- On chip clock generation:
 - 2 TTL clock inputs, or
 - Single 16 or 32 MHz crystal circuit and one TTL clock input
- Power Qualified Reset
 - Enable PQR in WD76C20
 - Disable PQR in WD76C20LV
- Host interface read/write accesses compatible with 80286 microprocessors at speeds up to 12 MHz with 0 wait states
- Direct floppy disk drive interface no buffers needed
 - 48 mA sink output drivers
 - Schmitt Trigger input line receivers
- FDC direct PC XT/AT interface compatibility
 - Floppy Control and Operations Registers on chip
 - In PC/AT mode, provides required signal qualification to DMA channel
 - IBM BIOS compatible
 - Dual-speed spindle drive support
- PS/2 type drive support
- Real Time Clock (RTC) features:
 - Software compatible with Motorola MC146818A.
 - · Internal time base and oscillator circuitry
 - · Counts seconds, minutes, and hours
 - Counts days of the week, date, month, and year
 - Time base input for 32.768 KHz square wave
 - Time base oscillator for parallel resonant crystals
 - Binary or BCD representation of time, calendar, and alarm

1

- 12- or 24-hour clock with AM and PM in 12-hour mode
- · Daylight savings time option
- Automatic leap year compensation
- Interfaced with software as 128 RAM locations
- 114 bytes of general purpose RAM
- · Status bit indicates data integrity

- Bus compatible interrupt signals (IRQ)
- Three interrupts are separately software maskable and testable:
 - Time-of-day alarm once-per-second to once-per-day
 - Periodic interrupt rates from 122 us to 500 ms
 - End-of-clock update cycle



FIGURE 1-1. SYSTEM LEVEL FUNCTIONAL BLOCK DIAGRAM

1.3 GENERAL DESCRIPTION

The WD76C20 is a member of the WD7600 chip set which provides a cost-effective, power-efficient solution to PC systems design, especially those relating to "lap-top" devices. The set includes the WD76C10, the WD76C20, and the WD76C30 as shown in Figure 1-1. Together these chips provide all necessary logic to build a fully integrated system board for several varieties of IBM PC/AT compatibles including systems using 80286, 80386SX, and 80C286 processors.

As part of this chip set, the WD76C20 provides these integral functions:

- Bus Interface Logic
- IDE Interface
- · Chip Select Logic
- Floppy Disk Controller
- · Real Time Clock
- Suspend/Resume Logic

The Floppy Disk Controller (FDC) component provides necessary timing and signalling between the host processor peripheral bus and a floppy disk drive through a cable connector.

The Real Time Clock component provides calendar and clock information for the system.

The IDE Interface controls buffering between the system's AT Bus and PC/AT compatible IDE drive interface.

The Bus Interface Logic controls buffering of data between the system's AT Bus and the WD76C20.

The Chip Select Logic section provides decoding for selected chip functions both within the WD76C20 and on the PC/AT motherboard.

Suspend/Resume Logic provides support for chip set power-down and resume sequences.

The remainder of this manual contains the following information:

Section 2 discusses the basic system architecture.

Section 3 provides signal descriptions.

Section 4 discusses the Chip Select Logic in more detail.

Section 5 discusses the Floppy Disk Controller in more detail.

Section 6 provides additional information on the IDE Interface.

Section 7 provides information on the Real Time Clock and SRAM.

Section 8 gives more information on the Suspend/Resume Logic.

Section 9 provides DC Operating Characteristics.

Section 10 provides AC Interface Timing.

Section 11 shows two package diagrams.

Appendix A lists the specifications for the WD76C20LV device.

2.0 ARCHITECTURE

The WD76C20 has three principal functions as illustrated in Figure 2-1. First, it exchanges control signals with the WD76C10 System Controller. Second, under control of the WD76C10, it exchanges data and qualified operation/status information with the Host via the system's AT Bus. Third, it provides complete control and data read/write services for one to four floppy disk units.

Internally, the WD76C20 has the following functional components:

- Bus Interface Logic
- Chip Select Logic
- IDE Drive Interface
- Floppy Disk Controller
- Real Time Clock and associated SRAM
- Suspend/Resume Logic



FIGURE 2-1. WD76C20 FUNCTIONAL BLOCK DIAGRAM

These functional components are described briefly in the following sections.

For a more detailed description of Chip Select Logic, IDE Interface Support, Floppy Disk Controller, Real Time Clock, and the Suspend/Resume Logic, refer to Sections 4 through 9. Signals mentioned in the following discussion are listed and described in Section 3.

2.1 **BUS INTERFACE LOGIC**

The chip's Bus Interface controls the buffering of bits D0-D7 passing between the system's AT Bus and any WD76C20 internal source/destination 8-bit storage cell via the internal bus. The Bus Interface receives the IOR and IOW signals from the WD76C10, and with the appropriate chip selects from the Chip Select Logic (CSL), it parallel-passes D0-D7 from the AT Bus to an internal WD76C20 cell, or vice versa. The internal cells which the Bus Interface Logic reads/writes to are:

- The Control, Master Status, Status, Data, or Operation Registers in the Floppy Disk Controller
- The 128 registers in the SRAM affiliated with the Real Time Clock.

The Bus Interface Logic also provides a controlled bidirectional path for bit D7 between the AT Bus and the IDE Drive Port.

2.2 CHIP SELECT LOGIC

The Chip Select Logic (CSL) component of the WD76C20 provides the decoding needed both for selecting chip functions within the WD76C20 and on the PC/AT motherboard. It receives the DPL, DPH, and RA8-RA10 signals from the WD76C10 Systems Controller and outputs appropriately decoded chip select signals (detailed in Section 3). Overall control of the decoding processes is accomplished using the CSEN and DACKEN signals from the WD76C10. CSEN enables the decoded output, while DACKEN causes the CSL to ignore the inputs from the WD76C10.

2.3 FLOPPY DISK CONTROLLER

The Floppy Disk Controller (FDC) portion of the WD76C20 is a VLSI Super Cell that provides all functions required between the host processor peripheral bus and the cable connector to the floppy disk drive. This provides a comprehensive solution to floppy subsystem control. Among its many features, the FDC possesses a software-transparent power-down mode which facilitates the chip's use in lap-top and portable systems. For more information on this component, refer to Section 5.

2.4 REAL TIME CLOCK AND SRAM

The Real Time Clock (RTC) component of the 76C20, in conjunction with the 128-byte register file, provides both calendar (day-of-week, day-ofmonth, month, and year) and clock (hours, minutes, and seconds) information, along with clocked alarms and a periodic interrupt. This interface gets signals from the 76C20 Bus Interface and Chip Select Logic functions and appropriately buffers bits D0-D7 between the 76C20 internal bus and the RTC internal bus accessing the SRAM.

2.5 SUSPEND/RESUME LOGIC

This functional block is used in conjunction with the RTC time base to provide a 14.318 MHz clock output to the WD76C10. This can switch to a 32,768 KHz clock during the low-power Suspend mode. This logic supports the WD7600 powerdown and resume sequencing required to run the Floppy Disk Controller and other components during low power.

5

3.0 SIGNAL DESCRIPTION

Figure 3-1 illustrates the signal names and pin locations on the 84-pin PLCC/PQFP WD76C20 package. Table 3-1 lists the signal names by pin

number and Table 3-2 lists the signal names alphabetically. Table 3-3 lists the signal names and descriptions grouped by function.



FIGURE 3-1. WD76C20 PIN DIAGRAM

| NAME | PIN | NAME | PIN | NAME | PIN | NAME | PIN |
|---------|-------|-----------|-----|--------|-----|-------------|------------|
| A0 | 45 | DS1 | 20 | MO2 | 26 | ROMOE | 78 |
| BALE | 59 | DS2 | 21 | MO3 | 27 | RPM/RWC | 29 |
| CSEN | 50 | DS3 | 22 | MX14 | 63 | RTCIRQ | 69 |
| CSIDE0 | 83 | EMS | 72 | MX14 | 64 | RTCX | 60 |
| CSIDE1 | 82 | FIRQ | 9 | NPCS | 76 | RTCX | 61 |
| CSPAR0 | 79 | FCLK1/FX1 | 4 | OSC | 68 | RWC/RPM | 29 |
| CSSERB | 80 | FCLK2 | 6 | PCUW1 | 74 | STEP | 18 |
| CSSERA | 81 | FX1 | 3 | PCUW0 | 75 | TC | 70 |
| CS8042 | 77 | FX1/FCLK1 | 4 | PCVAL | 11 | TR00 | 32 |
| DACK | 47 | HDL | 28 | PDREF | 66 | VBAT | 62 |
| DACKEN | 51 | HS | 13 | PRDY | 71 | VDD | 5,44,67 |
| DB0-DB7 | 35-42 | IDEDENH | 1 | PROGCS | 73 | VSS 2,16,25 | 5,34,46,65 |
| DCHG | 10 | IDEDENL | 84 | PWRDN | 30 | WD | 15 |
| DIRC | 17 | IDED7 | 43 | RA8 | 56 | WE | 14 |
| DMA | 8 | IDX | 33 | RA9 | 55 | WP | 31 |
| DPH | 52 | IOR | 48 | RA10 | 54 | | |
| DPL | 53 | IOW | 49 | RCLR | 58 | | |
| DRV/PS2 | 12 | MOO | 23 | RDD | 7 | | |
| DS0 | 19 | MO1 | 24 | RESET | 57 | | |

TABLE 3-1. PIN ASSIGNMENTS (ALPHABETICAL ORDER)

| PIN | NAME | PIN | NAME | PIN | NAME | | PIN | NAME |
|-----|---------|-----|-------|-----|--------|---|-----|---------|
| 1 | IDEDENH | 22 | DS3 | 43 | IDED7 | | 64 | MX14 |
| 2 | VSS | 23 | MOO | 44 | VDD | | 65 | VSS |
| 3 | FX1 | 24 | MO1 | 45 | A0 | { | 66 | PDREF |
| 4 | FX1 | 25 | VSS | 46 | VSS | | 67 | VDD |
| 5 | VDD | 26 | MO2 | 47 | DACK | - | 68 | OSC |
| 6 | FCLK2 | 27 | MO3 | 48 | IOR | Ì | 69 | RTCIRQ |
| 7 | RDD | 28 | HDL | 49 | IOW | | 70 | тс |
| 8 | DMA | 29 | RWC | 50 | CSEN | | 71 | PRDY |
| 9 | FIRQ | 30 | PWRDN | 51 | DACKEN | | 72 | EMS |
| 10 | DCHG | 31 | WP | 52 | DPH | | 73 | PROGCS |
| 11 | PCVAL | 32 | TR00 | 53 | DPL | | 74 | PCUW1 |
| 12 | DRV/PS2 | 33 | IDX | 54 | RA10 | | 75 | PCUW0 |
| 13 | HS | 34 | VSS | 55 | RA9 | ĺ | 76 | NPCS |
| 14 | WE | 35 | DB0 | 56 | RA8 | | 77 | CS8042 |
| 15 | WD | 36 | DB1 | 57 | RESET | | 78 | ROMOE |
| 16 | VSS | 37 | DB2 | 58 | RCLR | | 79 | CSPAR0 |
| 17 | DIRC | 38 | DB3 | 59 | BALE | | 80 | CSSEPB |
| 18 | STEP | 39 | DB4 | 60 | RTCX | | 81 | CSSEPA |
| 19 | DS0 | 40 | DB5 | 61 | RTCX | | 82 | CSIDE1 |
| 20 | DS1 | 41 | DB6 | 62 | VBAT | | 83 | CSIDE0 |
| 21 | DS2 | 42 | DB7 | 63 | MX14 | | 84 | IDEDENL |

TABLE 3-2. PIN ASSIGNMENTS (NUMERICAL ORDER)

| PIN | MNEMONIC | SIGNAL NAME | I/O | DESCRIPTION |
|-----|---------------------------------------|-------------------------------------|-------|---|
| | • • • • • • • • • • • • • • • • • • • | INTEGRATE | D DRI | VE ELECTRONICS (IDE) |
| 1 | IDEDENH | IDE High Byte Drive Enable | 0 | CMOS level output goes active low to enable the IDE Drive Interface Bus transceivers for the high byte of <u>of the 16</u> -bit interface. The signal is used with the CSIDEO card select output signal to the IDE drive only during 16-bit IDE data transfers. |
| 43 | IDED7 | IDE Data Bit 7 | 1/0 | TTL level I/O providing a data path for bit 7 between the Host and the IDE drive interface. IDED7 is an output, passing data to the IDE drive from DB7 of the Host data bus whenever an IOW to the IDE drive interface is detected. IDED7 is an input, passing data from the IDE drive to DB7 of the Host data bus when- ever an IOR of the IDE drive interface is detected, <u>except</u> when reading from address 3F7H. During an IOR of 3F7H, the floppy DCHG status is output on the Host data bus pin DB7. |
| 82 | CSIDE1 | IDE Card Selected Aux. Registers | 0 | CMOS level output is used by the Host to address and communicate with the IDE drive auxiliary regis- ters. Host activates the signal through a decode in the CSL logic block, while at the same time asserting IDEDENL. |
| 83 | CSIDEO | IDE Card Selected Registers 0-7 | 0 | CMOS level output is used by the Host to address and communicate with the IDE drive on the I/O chan- nel. The Host activates the signal through a decode in the <u>CSL log</u> ic block, <u>while at the same time asser-</u> ting IDEDENL or both IDEDENL and IDEDENH. |
| 84 | IDEDENL | IDE Low Byte Drive Enable | 0 | CMOS level output goes active low to enable the IDE drive interface bus transceivers for the low byte of the 16-bit Interface. The signal is used with the CSIDE0 card select output signal to the IDE drive only during 16-bit IDE data transfers. |
| | | F | IOST | INTERFACE |
| 8 | DMA | FDC DMA Request | 0 | DMA request for byte transfers of data. In PC/AT mode, this pin is tri-stated, enabled by DMAEN signal from the Operations Register. |
| 45 | AO | BIL Address Line | I | Address line selecting data (= 1) or status (= 0) infor- mation for the FDC. $A0 = 0$ during IOW is illegal except when putting the FDC into sleep mode. |
| 47 | DACK | FDC DMA Acknowledge | | Used by DMA controller to transfer <u>data from</u> FDC onto the bus. Logical equivalent to FDCS and A0=1. In PCAT mode, this signal is qualified by DMAEN from the Operations Register. |

TABLE 3-3. SIGNAL DESCRIPTIONS

| PIN | MNEMONIC | SIGNAL NAME | I/O | DESCRIPTION |
|-----|----------|---------------------------------------|---------|--|
| | <u> </u> | НС | OST INT | ERFACE (cont.) |
| 48 | IOR | BIL Input/Output Read | I | Read enable allowing data or status information to be transferred onto data bus by the WD76C20. |
| 49 | IOW | BIL Input/Output Write | . | Write enable latching data from the bus into sub- system buffer registers. |
| 57 | RESET | Chip Reset | I | TTL input resets the WD76C20 with the exception of the normal timekeeping operations which will remain uninterrupted. Resets all device outputs. Resets FDC controller, placing microsequencer in idle PC/AT mode. |
| | | F | LOPPY | ÓDISK CONTROL |
| 3 | FX1 | FDC XTAL Output #1 | 0 | This pin is an osc <u>illator</u> drive output for a 16 MHz resonant crystal. FX1 should be left floating if a TTL level clock is used at pin FX1. |
| 4 | FX1 | FDC XTAL | 1 | XTAL oscillator input requiring a 16 MHz resonant |
| | FCLK1 | Input #1 FDC CLK Input #1 | 1 | crystal. This oscillator is used for all standard data rates, and may be driven with a 16 MHz TTL level signal instead of using the 16 MHz crystal. |
| 6 | FCLK2 | FDC CLK Input #2 | | TTL level input used for non-standard data rates; can be driven with a 9.6 MHz clock for 300 Kb/s MFM data rate and only be selected from the control register. |
| 7 | RDD | FDC Read Disk | 1 | This is the raw serial bit stream from the disk drive. Each falling edge of the pulses represents a flux transition of the encoded data. |
| 9 | FIRQ | FDC Interrupt Request | 0 | Interrupt request indicating completion of command execution or data transfer requests (non-DMA mode). In PCAT mode, this pin is tri-stated, enabled by DMAEN signal from the Operations Register. |
| 10 | DCHG | FDC Disk Changed | 1 | This Schmitt Trigger (ST) input senses status from the disk drive indicating active low and drive door is open or that the diskette has possibly changed since last drive selection. The pin has an internal pull-up register. |
| 11 | PCVAL | FDC Precompensa- tion Value Select | 1 | This pin determines the amount of write precompen- sation used on the inner tracks of the diskette. Logic 1 = 125 ns, $0 = 187$ ns. In the defeat option, the PCVAL input is a don't care, and internally the pre- comp value is disabled. |

| PIN | MNEMONIC | SIGNAL NAME | I/O | DESCRIPTION |
|-----|------------|--|--------|--|
| | <u> </u> | FLOPP | Y DISH | CONTROL (cont.) |
| 12 | DRV PS2 | FDC Drive Type FDC PS2 Drive Type | 0 | In the input mode, a logic 0 indicates to the FDC that a 2-speed spindle motor is present and that FCLK2 should be grounded because it will not be used. As an option, this pin can be defined as an output to support the floppy drive connector pin 2 for PS/2 style drives, indicating the FDC is set internally for a single spindle motor. The pin has an internal pull-up resistor. |
| 13 | HS | FDC Head Select | 0 | This high current driver (HCD) output selects the head, i.e., side, of the floppy disk that is being read or written. Logic 1 = side 0, logic 0 = side 1. |
| 14 | WE | FDC Write Enable | 0 | This HCD output becomes true, active low, just prior to writing on the diskette. This allows current to flow through the write head. |
| 15 | WD | FDC Write Data | 0 | This HCD is the write data output. Each falling edge of the encoded data pulse stream causes a flux transition on the media. |
| 17 | DIRC | FDC Stepper Direction | 0 | This HCD output determines the direction of head stepper motor. Logic $1 =$ outward motion, logic $0 =$ inward motion. |
| 18 | STEP | FDC Stepper Step | 0 | This HCD output issues an active low pulse for each track to track movement of the head. |
| 28 | HDL | FDC Head Load | 0 | This HCD output, when active low, causes the head to be loaded against the media in the selected drive. |
| 29 | RWC RPM | FDC Reduce Write Current Revolutions Per Minute | 0 | This HCD output, when active low, causes a reduced write current when bit density is increased toward the inner tracks, becoming active when tracks > 2 . In PCAT mode, this signal can be used on 2-speed drives to select 300 RPM, active low, when 250 MFM or 125 FM KBs is selected and DRV = 0. |
| 30 | PWRDN | FDC Power Down | 0 | CMOS output, when active high, indicates the FDC portion of the WD76C20 has gone into power down mode. This signal can be used to power-down the floppy drive if supported. |
| 31 | WP | FDC Write Protected | 1 | This Schmitt Trigger (ST) input senses status from the disk drive indicating active low when a diskette is write-protected. |

5

| PIN | MNEMONIC | SIGNAL NAME | I/O | DESCRIPTION |
|-----|----------|----------------------------|--------|---|
| | - | FLOPP | Y DISI | <pre>K CONTROL (cont.)</pre> |
| 32 | TROO | FDC Track Zero | 1 | This ST input senses status from the drive indicating active low, when the head is positioned over the outermost track, track 00. |
| 33 | ĪDX | FDC Index Hole | I | This ST input senses status from the drive indicating active low when the head is positioned over the beginning of a track, marked by an index hole. |
| | | | CHI | PSELECT |
| 50 | CSEN | CSL Chip Select Enable | | Chip Select Enable TTL input used to output enable the appropriate CSL control line as decoded from the RA8, RA9, RA10, DPL and DPH inputs. <u>When</u> DACKEN is asserted low, the function of CSEN is negated. When used to enable and disable the WD76C30 48 MHz clock, CSEN acts as a strobe to a latch. When it and DACKEN are both asserted, the TC output will go high. |
| 51 | DACKEN | CSL Dack Enabled | I | TTL input that indicates the host is performing a DMA transfer unrelated to the WD76C20. When active high, it is used to disqualify all CSL input lines. |
| 52 | DPH | CSL Address Parity High | I | Decoded chip select TTL input pad, bit CS4. |
| 53 | DPL | CSL Address Parity Low | ł | Decoded chip select TLL input pad, bit CS3. |
| 54 | RA10 | CSL Address Line 10 | 1 | Decoded chip select TTL input pad, bit CS2. |
| 55 | RA9 | CSL Address Line 9 | 1 | Decoded chip select TTL input pad, bit CS1. |
| 56 | RA8 | CSL Address Line 8 | I | Decoded chip select TTL input pad, bit CS0. |
| 58 | BALE | CSL Bus ALE | 1 | TTL input which, when active high, causes latches on the CSL Input Code (CSEN, DPH, DPL, RA10, RA9, RA8) to become transparent. When BALE is forced low, the data in the transparent latches is latched. This pin has an internal pull-up resistor so the pin can be left unconnected and the latches transparent. |
| 70 | тс | CSL Host Terminal Count | 0 | CMOS level output used to indicate the final count has been reached during a host DMA transfer unrelated to the WD76C20. It is also used internally by the FDC to indicate a DMA transfer to the floppy drive is complete. TC asserts high when both <u>DACKEN and CSEN are asserted.</u> (DACKEN=1, CSEN=0). |

TABLE 3-3. SIGNAL DESCRIPTIONS (CONTINUED)

.

| PIN | MNEMONIC | SIGNAL NAME | I/O | DESCRIPTION |
|-----|----------|---|--------|--|
| | | | | ELECT (cont.) |
| 71 | PRDY | CSL Processor Ready | I | ST input senses processor ready status to help latch the CSL inputs correctly during system byte swapping activities. This pin has an internal pull-up resistor so that it can be left unconnected when not needed. The PRDY input should be used in system designs that use the BALE pin. |
| 72 | EMS | CSL External EMS Access | 0 | CMOS card select output decoded from CSL input lines and issued to select external EMS. |
| 73 | PROGCS | CSL Program Chip Select | 0 | CMOS chip select output decoded from CSL input lines and issued as a programmable chip select. |
| 74 | PCUW1 | CSL Power Control Unit Write Strobe #1 | 0 | CMOS write strobe output decoded from CSL input lines and issued to write to the PCU #1. |
| 75 | PCUW0 | CSL Power Control Unit Write Strobe #0 | 0 | CMOS write strobe output decoded from CSL input lines and issued to write to the PCU #0. |
| 76 | NPCS | CSL Numerical Processor Chip Select | 0 | CMOS chip select output decoded from CSL input lines and issued to select the numerical processor, the 80287. |
| 77 | CS8042 | CSL 8042 Chip Select | 0 | CMOS chip select output decoded from CSL input lines and issued to select the 8042. |
| 78 | ROMOE | CSL ROM Output Enable | 0 | CMOS chip select output decoded from CSL input lines and issued to output enable the BIOS ROM. |
| 79 | CSPAR0 | CSL Parallel Port #0 Chip Select | 0 | CMOS chip select output decoded from CSL input lines and issued as a chip select to the WD76C30 to enable the parallel port #0. |
| 80 | CSSSEB | CSL Serial Port B Chip Select | 0 | CMOS chip select output decoded from CSL input lines and issued as a chip select to the WD76C30 to enable the serial port B. |
| 81 | CSSERA | CSL Serial Port A Chip Select | 0 | CMOS chip select output decoded from CSL input lines and issued as a chip select to the WD76C30 to enable the serial port A. |
| | | F | REAL 7 | TIME CLOCK |
| 58 | RCLR | RTC RAM Clear | | A dual function pin. As long as it is held low, all 76C20 outputs are held in a high impedance state to facilitate testing. It is also used as a ST input to clear all 114 bytes of the general purpose RAM. None of the clock or calendar functions are interrupted, and the 14 registers that are used by the RTC are left unchanged. This pin has an internal pull-up so it can be left unconnected. |

5

| PIN | MNEMONIC | SIGNAL NAME | I/O | DESCRIPTION | |
|------------------------|----------|-----------------------------------|-------|---|--|
| | | REA | L TIM | E CLOCK (cont.) | |
| 60 | RTCX | RTC Time Base XTAL Out | 0 | XTAL oscillator output for parallel resonant AT cut crystal at 32.768 KHz. | |
| 61 | RTCX | RTC Time Base XTAL In | I | 32.768 KHz XTAL oscillator input for use with crystal oscillator circuit. | |
| 62 | VBAT | RTC Battery Backup | NA | Battery backup power supply VDD pin. A 3-volt battery connector can be attached to maintain the RTC timekeeping functions and SRAM integrity during system power-downs. (See Figure 2-3a) | |
| 69 | RTCIRQ | RTC Interrupt Request | 0 | Open-drain CMOS output that is set to tri-state unless the RTC needs to interrupt the processor, when the pin goes low and stays low until register C is read, or the part is reset through the RESET pin. | |
| SUSPEND/RESUME SUPPORT | | | | | |
| 63 | MX14 | S/R 14.318 MHz Crystal In | | Crystal oscillator input for the 14.318 MHz oscillator. | |
| 64 | MX14 | S/R 14.318 MHz Crystal Out | 0 | Crystal oscillator output for the 14.318 MHz oscillator. | |
| 66 | PDREF | Suspend/Resume DRAM Refresh | 0 | External DRAM refresh line used to support the WD76C10 when it goes into Suspend/Resume mode. During Suspend/Resume mode, this pad provides a 1.0 μ S \pm 0.5 μ S pulse once every 15.26 μ S a (using a 50% duty cycle) and is used to maintain the DRAM integrity with as little power as possible. The Suspend/Resume mode is entered when a CSL address of 15H is detected and exited when a CSL address of 16H is issued. | |
| 68 | OSC | S/R WD76C10 Clock Driver | ο | CMOS level clock driver output used to support the WD76C10. When not in the WD76C10's suspend/ resume mode, the output waveform is a 14.318 MHz square wave, and when in suspend/resume mode, it becomes a 32.768 KHz square wave. The WD76C10 suspend/resume mode is entered when a CSL address of 15H is detected and exited when a CSL address of 16H is issued. | |
| | | , | DA | ATA BUS | |
| 35- 42 | DB(0-7) | BIL Processor Data/Address Bus | 1/0 | 8-bit bi-directional, tri-stateable data bus. | |

| PIN | MNEMONIC | SIGNAL NAME | I/O | DESCRIPTION |
|-------|------------------------------|---------------------|-------|---|
| | | Λ | ЛОТО | R CONTROL |
| 23 | MOO | FDC Motor on #0 | 0 | This HCD output, when active low, is motor on enable for disk drive #0, in PCAT mode. |
| 24 | MO1 FDC Motor on #1 | | 0 | This HCD output, when active low, is motor on enable for disk drive #1, in PCAT mode. |
| 26 | MO2 | FDC Motor on #2 | 0 | Reserved for 4 Mbyte support (density select). |
| 27 | MO3 | FDC Motor on #3 | 0 | Reserved for 4 Mbyte support (density select). |
| | | | | 'E SELECT |
| 19 | DS0 | FDC Drive Select #0 | 0 | This HCD output, when active low, is Drive #0 select in PC/AT mode, enabling the interface in the disk drive. The signal is qualified by the MOEN0 bit. |
| 20 | DS1 | FDC Drive Select #1 | 0 | This HCD output when active low is Drive #1 select in PC/AT mode, enabling the interface in the disk drive. The signal is qualified by the MOEN1 bit. |
| 21 | DS2 | FDC Drive Select #2 | 0 | This HCD output, when active low, is Drive #2 select in PC/AT mode, enabling the interface in the disk drive. The signal is qualified by the MOEN2 bit. |
| 22 | DS3 | FDC Drive Select #3 | 0 | This HCD output, when active low, is Drive #3 select in PC/AT mode, enabling the interface in the disk drive. The signal is qualified by the MOEN3 bit. |
| | · | I | MISCE | ELLANEOUS |
| | 2, 16, 25, VSS 34, 46, 65 | | | Ground |
| 5, 44 | , 67 | VDD | | +5V Power |
| 3 | | | | |

4.0 CHIP SELECT LOGIC

The Chip Select Logic is handled cooperatively by all the chips in the chip set, with each chip contributing its part to the logic. The WD76C10 and WD76C20 are particularly interrelated. Many of the decoding operations begun by the WD76C10 are handed to the WD76C20 for completion, and vice versa. For this reason, it is necessary to read both this section and section 7 of the WD76C10 for the fullest possible understanding of this function.

The Chip Select Logic of the WD76C20 provides decoding of five CSL input lines, DPH, DPL, RA10-8, into 17 output lines.

Figure 4-1 provides a block diagram of the inputs and outputs associated with this component.

Before the decoder can function, it must be enabled by CSEN going active low and remains open until it is disabled by DACKEN going active high. Optionally, the chip select inputs (CSEN, DPH, DPL, RA10, RA9, RA8) can be latched by dropping the BALE from 1 to 0. These latches are transparent when BALE is held high or left unconnected.

Once enabled, the Chip Select Logic provides decoding for the following signals, as shown in Table 4-1.

Table 4-2 lists the I/O addresses and chip selects generated for each fixed port. Address bits A15 through A10 are ignored for the I/O addresses listed with three digits. The ports are listed in the sequence of the chip select value.



FIGURE 4-1. CHIP SELECT BLOCK DIAGRAM

| | | CSL | INPUT L | INES | in in in | |
|-----|-----|-----|---------|------|----------|--|
| CS# | DPH | DPL | RA10 | RA9 | RA8 | FUNCTION |
| оон | o | 0 | 0 | 0 | 0 | Assert ROMOE to Output Enable the ROM BIOS ¹ |
| 01H | 0 | 0 | о | 0 | 1 | Assert CS8042 to Chip Select the Keyboard Control ¹ |
| 02H | 0 | 0 | 0 | 1 | 0 | Assert NPCS to Chip Select the Numeric Processor ¹ |
| 03Н | 0 | 0 | o | 1 | 1 | Assert PCUW0 to Write Strobe PCU #0 |
| 04H | 0 | 0 | 1 | 0 | 0 | Assert LCLACK to acknowledge Keyboard Processor ¹ |
| 05H | 0 | 0 | 1 | 0 | 1 | Assert RTC ALE for RTC I/O ¹ |
| 06H | 0 | 0 | 1 | 1 | 0 | Assert RTC Write Strobe Gated by CSEN & IOW ¹ |
| 07H | 0 | 0 | 1 | 1 | 1 | Assert RTC Read Stobe Gated by CSEN & IOR ¹ |
| 08H | 0 | 1 | 0 | 0 | 0 | Assert FDC LDOR Register Select Line ¹ |
| 09Н | 0 | 1 | 0 | 0 | 1 | Assert FDC FDCS Chip Select Line ¹ |
| 0AH | 0 | 1 | 0 | 1 | 0 | Assert FDC LDCR Register (Read/Write) Select Line ¹ |
| овн | 0 | 1. | 0 | 1 | 1 | Assert FDC LDCR Register (Read/Write) Select Line & assert IDEDENL and CSIDE1 IDE Card Select Lines ¹ |
| осн | 0 | 1 | 1 | 0 | 0 | Assert $\overline{\text{IDEDENL}}$ and $\overline{\text{CSIDEO}}$ IDE Card Select Line & assert $\overline{\text{IDEDENH}}$ if A0 = 0 ¹ |
| ODH | 0 | 1 | 1 | 0 | 1 | Assert IDEDENL and CSIDE ¹ IDE Card Select Line ¹ |
| 0EH | 0 | 1. | 1 | 1 | 0 | Assert CSSERA to Chip Select Serial Port A ¹ |
| 0FH | 0 | 1 | 1 | 1 | 1 | Assert CSPAR0 to Chip Select Parallel Port 01 |
| 10H | 1 | 0 | 0 | 0 | 0 | Assert CSSERB to Chip Select Serial Port B1 |
| 11H | 1 | 0 | 0 | 0 | 1 | Assert PROGCS ¹ |
| 14H | 1 | 0 | 1 | 0 | 0 | Assert EMS to signify external EMS memory access ¹ |
| 15H | 1 | 0 | 1 | 0 | 1 | WD76C30 <u>48 MHz</u> Clk <u>Disable</u> , CSL Latches Code, OSSERA, CSSERB & CSPAR0 stay asserted ² |
| 16H | 1 | 0 | 1 | 1 | 0 | 48 MHz <u>Clk Enable for WD76C30, CSL u</u> nlatches code, so CSSERA, CSSERB & CSPAR0 deassert ³ |
| 17H | 1 | 0 | 1 | 1 | 1 | Assert PCUW1 to Write Strobe PCU #1 |

TABLE 4-1. CHIP SELECT LINE DECODER

¹ These signals are generated using latched CSL inputs if BALE is used.
 ² Suspend Mode is entered by asserting code 15H on the CSL inputs, while qualifying it by CSEN=0, IOW=0, and the falling edge of OSC.
 ³ Suspend Mode is left by asserting code 16H on the CSL inputs, while qualifying it by an OSC falling edge.

| PORT | I/O ADDRESS | CS# | FUNCTION | |
|--------------------------------------|--|-----------------|---|--|
| ROM Chip Select | N/A | 00 | Chip Select for BIOS ROM | |
| Keyboard Control | 060 - 06E Even | 01 | Chip Select For 8042 | |
| 80287 | 00E0 - 00FF | 02 | Chip Select for Numeric Processor | |
| Power Control | 7072 | 03 | PMC Write Strobe 0 | |
| Reserved | | 04 | Reserved | |
| Real Time Clock | 070 | 05 | RTC ALE | |
| Real Time Clock | 071 | 06 | RTC Write Stroke | |
| Real Time Clock | 071 | 07 | RTC Read Strobe | |
| Floppy Operation Chip Select | 3F2 372 | 08 | Primary Address Secondary Address | |
| Floppy Chip Select | 3F4, 3F5 374, 375 | 09 | Primary Address Secondary Address | |
| Floppy Control Chip Select | 3F7 377 | 0A | Primary Address Secondary Address (Floppy Enabled, HD Disabled) | |
| Floppy And HD Control Chip Select | | 0B | Primary Address Secondary Address (Floppy Enabled, HD Enabled) | |
| Hard Disk Chip Select | 1F0, 1F1 - 1F7 170, 171 - 177 | 0C | Primary Address Secondary Address | |
| Hard Disk Chip Select | 3F6, 3F7 ¹ 376, 377 ¹ | 0D | Primary Address, IDE Mode Only Secondary Address, IDE Mode Only | |
| Serial Port A Chip Select | 2E8 - 2EF 2F8 - 2FF 3E8 - 3EF 3F8 - 3FF | 0E ² | | |
| Parallel Port 0 Chip Select | 278 - 27F 378 - 37F 3BC - 3BF | 0F | | |
| Serial Port B Chip Select | 2E8 - 2EF 2F8 - 2FF 3E8 - 3EF 3F8 - 3FF | 10 ² | | |
| Program Chip Select | PROG | 11 | | |
| SCSI | 3530 - 353X | 12 | | |
| Cache Flush | F872 | 13 | | |
| EMS | — - — - | 14 | External EMS | |
| | F072 | 15 | 48 MHz Clock Disabled | |
| | F472 | 16 | 48 MHz Clock Enabled | |
| Power Control | 7872 | 17 | PMC Write Strobe 1 | |
| Reserved | | 1E, 1F | Reserved | |

TABLE 4-2. I/O ADDRESS AND CHIP SELECT ASSIGNMENTS

 1 IDE Hard Disk enabled, floppy disabled 2 CS# is the decoded value of CS4-CS0.

5.0 FLOPPY DISK CONTROLLER

This section discusses the Floppy Disk Controller in detail. The Floppy Disk Controller (FDC) consists of several logical and/or physical blocks, as illustrated in Figure 5-2.

These components are:

- The 765A-compatible Core
 - Clock & Timing Generator
- Drive Interface
 - Data Separator
 - Write Precompensator
- Host Interface
 - Control Register
 - Operations Register
 - Master Status Register
 - Disk Interface Control Register
 - Data Register

Each of these topics is discussed in the following sections.

5.1 765A-COMPATIBLE CORE

The WD76C20 maintains the core attributes of the 765A floppy disk controller. The micro-sequencer is functionally equivalent and all commands will execute identically, assuring software compatibility with the 765A standard. The floppy control state machine on the front-end is also functionally equivalent. The micro-sequencer and control state machine operate at 8 times the selected bit data rate in MFM and 16 times the bit data rate in FM.

5.1.1 Clock and Timing Generator

The FDC portion of the WD76C20 provides all clock generation necessary for the floppy disk subsystem including SCLK (Sampling Clock), WCLK (Write Clock) and MCLK (Master Clock).

A 16 MHz crystal oscillator circuit provides the necessary signals for internal timing when external clocks are unavailable. The 16 MHz signal handles all standard data rates (500 and 250 Kb/sec) used in PC/AT designs, and a non-standard data rate (300 Kb/sec.). If neither the board space nor the 16

MHz TTL clock is available, FCLK1/FX1 can be driven with a 16 MHz TTL-level clock, and FCLK2 with a 9.6 MHz TTL clock. This will handle standard data rates (500, 250, and 125 Kb/sec.), and a non-standard data rate (300 Kb/sec.).

5.1.1.1 SCLK

SCLK is the clock which drives the digital phase lock loop data separator during data recovery. This clock frequency is always 32 times the selected data rate, and is exactly the frequency of the signals on FX1 (FCLK1) and FCLK2, whether or not standard data rates are being used (see Table 5-1).

| FC | LK | SCLK | | | |
|------------|-------------|----------|-----------|--|--|
| FCLK1 | FCLK2 | Standard | Non-Stan. | | |
| 16 MHz TTL | 9.6 MHz TTL | 16 MHz | 9.6 MHz | | |
| 16 MHz TTL | Tied Low | 16 MHz | Disabled | | |

TABLE 5-1. FDC SAMPLING (SCLK) CLOCK

If the oscillator is not used, a 16 MHz TTL clock should be applied at FCLK1 (FX1) as shown in Figure 5-1. Data rates for this crystal are shown in Table 5-2.



FIGURE 5-1. 16 MHZ CRYSTAL

| DATA RATE | CODE | SCLK | MCLK | WCLK |
|------------|------|---------|---------|---------|
| 125 Kb/sec | FM | 4 MHz | 2 MHz | 250 KHz |
| 500 Kb/sec | MFM | 16 MHz | 4 MHz | 1. MHz |
| 250 Kb/sec | FM | 8 MHz | 4 MHz | 500 KHz |
| 250 Kb/sec | MFM | 8 MHz | 2 MHz | 500 KHz |
| 300 Kb/sec | MFM | 9.6 MHz | 2.4 MHz | 600 KHz |

5.1.1.2 WCLK

WCLK is used by the encoder logic to place MFM or FM on the serial Write Data stream to the disk. WCLK always has a frequency twice the selected data rate. See Table 5-2 for WCLK data rates.

5.1.1.3 MCLK

MCLK is used by the micro-sequencer. Both the MCLK and MCLK clocks latch in a 2-phase scheme. One micro-instruction cycle is 4 MCLK cycles. MCLK has a frequency equal to 8 times the selected MFM data rate or 16 times the FM data rate. See Table 5-2 for MCLK data rates.

5.1.1.4 Automatic Power-Down Mode

In this mode, the FDC powers down all circuitry except for the Data Register, the Operations Register, the Control Register, the Master Status Register and the I/O path leading to and from the data bus. Since the crystal oscillator controller circuitry and all non-essential linear circuitry is turned off, the controller will draw very low current. The FDC can return from power-down mode by simply polling the Master Status Register, after which the crystal oscillator turns on along with the other circuitry.

To resume on power-up, the FDC turns on the crystal oscillator, which in turn activates all the clock circuitry on the chip.

For more information on the Power-Down Modes, refer to Section 7.

5.2 DRIVE INTERFACE

The FDC's disk drive interface includes data separation and write precompensation in addition to the usual formatting, encoding/decoding, stepper motor control and status sensing functions. All inputs are TTL compatible, and outputs are high-current, open-drain drivers that conform to the ANSI specification of 48 mA.

The FDC no longer supports certain pin functions provided for in the 765 predecessor. The output RW/SEEK is used in the 765-based subsystem as a multiplexer select line to allow a pin to have 2 functions depending on whether a read, write, or seek type command is under execution. This signal is no longer available externally but is used within the WD76C20 to assure that no improper pin functionality occurs.

The LCT function has been renamed RWC and resides on a pin of its own with slightly altered active conditions and in the PC/AT mode is RPM. DIRC is the only function on that pin and is enabled only during seeks as a power conservation measure.

STEP is also only enabled during seeks and a fault rest (FR) is no longer needed since FLT, fault detects, are not sensed. FLT status - status register #3, bit 7 - will always be a logic 0 state. Also, track zero status, TR00, is only sensed during seeks.

Two-sided drive status, TS, is no longer supported, and Status Register #3, bits 6 and 3 will both now reflect Write Protect status. The FDC device assumes the drive is ready all the time since DRDY signal is set to logic 1 internally. This will still result in an FIRQ. This action is acknowledged as a change in status and demands a Sense Interrupt Status command execution in order to clear the FIRQ. Signals MFM, RDW, WCK and VCO are no longer needed since all logic associated with these is now contained within the FDC.

5.2.1 Data Separator

The FDC incorporates the patented digital phase lock loop used in the WD92C32 product. The sample clock rate, SCLK, must be 32 times the data rate.

5.2.2 Write Precompensation

The FDC maintains the standard first level algorithm to determine when write precompensation should be applied. The EARLY and LATE signals are used internally to select the appropriate delay in the Write Data pulse stream. The encoded write data signal is synchronized to the 16 MHz clock, if this is the frequency on pin FCLK1, and clocked through a shift register, FX1. Signals EARLY, NOM, and LATE determine the amount of delay through the shift register before a multiplexer gates the chosen bit to the output. The output data pulse width has 25% duty cycle which equals 1/4 of the bit cell period or 1/2 the WCLK period.

When PCVAL is set to 1, all data will be precompensated by ± 125 ns regardless of track number and data rate, but only for MFM encoding (no write precomp for FM). If PCVAL is 0, and if a track inside number 28 is accessed, then ± 187 ns of precomp will be generated. For frequencies other than 16 MHz on FX1, these precomp values will be 2 and 3 SCLK clock cycles respectively.

When a non-standard data rate using FCLK2 is chosen, the precompensation logic is run from this frequency. In this case, the PCVAL function is disabled. Hence precomp values will always be 2 clock cycles. For 9.6 MHz this value is ± 208 ns. The write precomp can be disabled by the use of bit 2 of Control register for PC AT. With no write precomp, the PCVAL input to the chip is ignored.

5.3 HOST INTERFACE

The host access signals are identical to a 765A floppy disk controller, but timings have been enhanced. The host interface has been designed to support up to 12 MHz bus speeds without the use of wait states. Input strobes are Schmitt Triggers. The data bus drive capability is 12 mA IOL, and 5 mA IOH, allowing, in most applications, direct interconnection to bus structures without the use of buffers or transceivers. For PC and PC/AT applications, qualification of interrupt request and DMA request is provided.

Traditionally, data rate selection, drive selection, and motor control have been output ports of the host processor architecture; however, in the PC AT these functions are latched into registers addressed within the system's I/O mapping. These registers, Operations and Control, are incorporated into the FDC.

The FDC has 8 internal registers.

- Control Register is a write register that provides support logic for selection of desired data rates and write precompensation logic.
- Disk Interface Control Register provides a read only register for determining the Disk Change status signal.
- Operations Register provides all the control signals required to select the drive and the spindle motor.
- Master Status Register is an 8-bit read/write register comprised of these two parts:
 - MSR is an 8-bit read only register containing FDC status information and may be accessed at any time.
 - MSR1 is an 8-bit write only register containing support for the Power Down Mode and the PS/2 drive type select.
- Status Registers 0-3 are four read only registers under system control providing various status and error information.
- Data Register is an 8-bit read/write register which stores data, commands, parameters, and FDD status information.

Selection of these registers is handled through the decoding of 7 lines as shown in Table 5-3.

| ADDRESS MAP | CS | A0 | LDCR | LDOR | R/W/RW |
|-------------------------|----|----|------|------|--------|
| MASTER STATUS REGISTER | 0 | 0 | _ | _ | R |
| MASTER STATUS REGISTER1 | 0 | 0 | _ | - | w |
| DATA REGISTER | 0 | 1 | _ | _ | R/W |
| OPERATIONS REGISTER | - | - | - | 0 | w |
| CONTROL REGISTER | | _ | 0 | - | w |
| DISK INTERFACE REGISTER | _ | _ | 0 | | R |

TABLE 5-3. FDC REGISTER MAP

5.3.1 Control Register

The Control Register is a Write register.

Address 3F7, $\overline{\text{LDCR}} = 0$, $\overline{\text{IOW}} = 0$ - Write only

The Control Register is used to set the data transfer rate and disable write precomp. On receiving an IOW, the WD76C20 latches the three LSB's of the data bus. These bits, along with CR1 and CR0 in the Control Register, are used as shown in Table 5-1 to select the desired data rate which, in turn, controls the internal clock generation. Clock switchover is internally corrected, allowing continuous operation after changing data rates. Switching this clock must be errorless or the device must be reset. For all non-standard transfer data rates, use Table 5-2.

As an option, FDC also supports a 150 Kb/sec FM data transfer rate. The Control Register is used to set the transfer data rate as shown in Table 5-2. FX1 (pin 4) can be driven with a TTL level 9.6 MHz signal. With this setup, only 150 Kb/sec (FM) and 300 Kb/sec (MFM) data transfer rates can be selected. If the Control Register is not used, the data rate is governed by the supplied clock, or crystal, frequency and must be 64 times the desired MFM data rate. This provides a maximum frequency of 16 MHz for the data rate of 250 Kb/sec.

In PC/AT mode, precomp can be disabled by the use of the No Write Precomp (NWP) bit in the Control Register as shown in Figure 5-3.

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|---|---|---|---|---------|-----|-----|
| | | | | | NWP | CR1 | CR0 |
| | | | | | · · · · | | |

| Signal Name | Default At Reset |
|----------------|---------------------|
| NWP | 0 |
| CR1 | 0 |
| CR0 | 0 |

Bits 7-3 - Reserved, not defined.

Bit 2 - NWP, No Write Precomp

In PC/AT mode, precomp can be disabled. This enables the PCVAL input pin.

NWP = 0 -

Write Precomp enabled.

NWP = 1 -Write Precomp disabled.

Bit 1 - CR1, Data Rate 1 CR1 = 0 -

Refer to Tables 5-4.

CR2 = 1 -Refer to Tables 5-4.

Bit 0 - CR0, Data Rate 0

CR0 = 0 -Refer to Table 5-4.

CR0 = 1 -Refer to Tables 5-4.



| DATA RATE | PC/AT RPM | MODE | CR1 | CR0 | DRV |
|------------|-----------|---------------------|-----|-----|-----|
| | | 16 MHZ | | | |
| 500 Kb/sec | 1 | MFM | 0 | 0 | X |
| 250 Kb/sec | 1 | FM | 0 | 0 | x |
| 250 Kb/sec | 0 | MFM | 0 | 1 | 0 |
| 300 Kb/sec | 0 | MFM (9.6 MHz) | 0 | 1 | 1 |
| 250 Kb/sec | 0 | MFM (Reset Default) | 1 | 0 | X |
| 125 Kb/sec | 0 | FM (Reset Default) | 1 | 0 | x |
| 125 Kb/sec | 0 | FM | 1 | 1 | X |
| | | 9.6 MHZ | | | |
| 300 Kb/sec | 1 | MFM | 0 | 0 | X |
| 150 Kb/sec | 1 | FM | 0 | 0 | x |

TABLE 5-4. FCLK1 DATA RATE DECODER

5.3.2 Disk Interface Control Register

The Disk Interface Control Register is a Read only register. It shares the same address as the Control Register but is accessed to indicate the state of DCHG. This signal helps decode Disk Interface Control logic by sensing status from the disk drive. It senses low if the drive door is open or the diskette has changed since the last drive selection.

Address 3F7, LDCR = 0 - Read only

During the Read Mode, bit 7 indicates the state of the Disk Change Status signal, DCHG. Bits 6 through 0 are tri-stated and used by the hard disk during this read.

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
|------|---|-----------|---|---|---|---|---|--|--|--|
| DCHG | | Tristated | | | | | | | | |
| | | | | | | | | | | |

| Signal | Default |
|---------|----------|
| Name | At Reset |
| Bit 6-0 | |

Bit 7 - D_CHG, Disk Changed status signal

D_CHG = 0 -

DCHG has not changed state.

D_CHG = 1 -

DCHG has changed state.

Bits 6-0 - Tri-stated

5.3.3 Operations Register

Address 3F2, $\overline{\text{LDOR}} = 0$, $\overline{\text{IOW}} = 0$, PCAT Mode - Write only

When the Operations Register receives an IOW, the data on the data bus is latched into the Operations Register. This register replaces the typical latched port seen in floppy subsystems used to control disk drive spindle motors and select desired drive.

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|---|---|---|---|-------|------|----|----|
| MOEN | | | | | DMAEN | SRST | DS | EL |
| 2 | | 2 | 4 | | | | 4 | 0 |
| 3 | | 2 | 1 | 0 | | | 1 | 0 |

| Signal Name | Default At Reset |
|----------------|---------------------|
| MOEN3-0 | 0 |
| DMAEN | 0 |
| SRST | |
| DSEL1-0 | |

Bits 7-4 - MOEN3-0, Motor On Enable 3-0

MOEN3 through MOEN0 produce the inverted outputs MO3, MO2, MO1, and MO0.

Bit 3 - DMAEN, DMA Enable

In PC/AT mode, FIRQ and DMA are tri-stated and qualified by DMAEN. The data bus is designed to handle 20 LSTTL loading.



Bit 3 = 0 -

DMA and FIRQ outputs and DACK input disabled.

Bit 3 = 1 -

DMA and FIRQ outputs and DACK input enabled.

Bit 2 - SRST, Soft Reset

Bit 2 = 0 -

The Floppy Disk Controller will be reset. After the Soft Reset has occurred, bit 2 is returned to a 1.

Bit 2 = 1 -

Normal or default state.

Bit 1, 0 - DSEL1, 0, Drive Select

The DSEL 1,0 drive select bits are valid only when in the PC/AT Mode.

| DS1 | DS0 | DRIVE SELECT |
|-----|-----|--------------|
| 0 | 0 | DS0 Active |
| 0 | 1 | DS1 Active |
| 1 | 0 | DS2 Active |

TABLE 5-5. DRIVE SELECT DECODE

5.3.4 Master Status Registers

The Master Status Register (MSR) is a Read/Write register. The Write Mode and Read Mode of the Master Status Register provide different functions and are discussed separately in this section.

The Write Mode MSR, called MSR1, sets the conditions for drive select and motor enable signals. It also checks for correct polarity on the DRV/PS2 pin for PS/2 drive types.

Table 5-6 shows the sequence to select the PS/2 type of drives and the polarity on DRV/PS2 pin which is tied to pin 2 on the floppy disk drive connector. If this register is not programmed for PS/2 configuration, the RWC output from FDC should go to pin 2 of the floppy disk drive connector. The default is AT mode which means that the RWC output from the FDC should be tied to Pin 2 of the FDC connector.

| A0 | IOR | IOW | Function |
|----|-----|-----|---|
| 0 | 0 | 1 | Read from Main Status Register (MSR) |
| 0 | 1 | 0 | Write into Main Status Register (MSR1) |
| 0 | 0 | 0 | Illegal |
| 1 | 0 | 0 | Illegal |
| 1 | 0 | 1 | Read from Data Register |
| 1 | 1 | 0 | Write into Data Register |

TABLE 5-6. MSR/DDR DECODE

The WD76C20 decodes for both the Master Status Register and the Data Register based on five signals: A0, RD, WR, RD, and WR as shown in Table 5-5.

5.3.4.1 MSR1: Power-Down and PS/2 Support

Address 3F4, A0 = 0, \overline{IOW} = 0 - Write only

In the Write Mode, the MSR1 register contains support for the Power Down Mode and the PS/2 drive type select. You may write to this register to enable the Power Down Mode (option 1), to disable user transparent Power-Down Mode (option 2), and set up the PS/2 type drive configuration. The Power Down-Mode is discussed in more detail in section 7.

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|------|---|----|-----|---|-------------|-----|
| 0 | стят | | PS | SEL | | PD2E NAB | PDM |
| 1 | 0 | 3 | 2 | 1 | 0 | | |

| Signal Name | Default At Reset |
|----------------|---------------------|
| CTST1,0 | 0 |
| PSSEL3-0 | |
| PD2ENAB | 1 |
| PDM1 | 0 |

The storage element for all bits is FF and the clock qualifier is MSRCK.

Bits 7,6 - CTS1-0, reserved

CTS1 and CTS0 should always be zero.

Bit 5 - PSSEL3

PSSEL3 = 1 -PS2 drive 3 is selected.

Bit 4 - PSSEL2

PSSEL2 = 1 -PS2 drive 2 is selected.

Bit 3 - PSSEL1

PSSEL1 = 1 -PS2 drive 1 is selected.

Bit 2 - PSSEL0

PSSEL0 = 1 -PS2 drive 0 is selected.

Bit 1 - PD2_ENAB, FDC Power Down Option 2

PD2_ENAB = 0 -

User-transparent Power Down Mode option 2 is disabled.

PD2_ENAB = 1 -

User-transparent Power Down Mode option 2 is enabled. A hard reset also enables the PDM option 2. Refer to section 7 for more details.

Bit 0 - PDM, FDC Power Down Mode Option 1

PDM = 0 - Disabled

PDM is set to 0 by a hard or soft reset.

PDM = 1 -

The FDC immediately enters the user-initiated Power Down Mode. Refer to section 7 for more details.

5.3.4.2 MSR: FDC Status Information

Address 3F4, A0 = 0, IOR = 0 - Read only

In the Read Mode, MSR contains FDC status information and can be accessed at any time.

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|------|-----|----|-----|-----|-----|-----|
| RQM | DI/O | EXM | СВ | D3B | D2B | D1B | D0B |
| | | | | e e | | | |

Signal Name

```
Default
At Reset
```

 ${\prime}{\prime}$

Bits 7-00

Bit 7 - RQM, Request For Master

RQM = 0 -The FDC is busy.

RQM = 1 -

The Data Register is ready to send to or receive data from the processor. RQM and DI/O should be used to perform handshaking functions specifying the ready status and signal direction to the processor.

| STEP | CODE | REGISTER VALUE | DESCRIPTION | RWC | DRV |
|------|------|-----------------------|---|-----|-----|
| 1. | 3F4 | 00 | Disable FDC Sleep Mode | - | - |
| 2. | 3F7 | 00 | Select 500 Kb/sec data rate and 3.5" 1.44 MB in AT Mode | 1 | 1 |
| 3. | 3F2 | 1C | Disable SRST, enable DS0, MO0, and DMAEN bits of Operations Register | 1 | 1 |
| 4. | 3F4 | 04 | Enable bit 2 of MSR and select PS2 drive 0 (1.44 MB) | 1 | · 1 |
| 5. | 3F2 | 1C | Disable SRST, enable DS0, MO0, and DMAEN bits of Operations Register | 1 | 0 |
| 6. | 3F4 | 08 | Enable bit 3 of MSR and select | _ | — |
| 7. | 3F7 | 02 | Select 250 Kb/sec data rate and 3.5" 720 KB | 0 | 0 |
| 8. | 3F2 | 2D | Disable SRST, enable DS1, MO1 and DMAEN bit of the Operations Register PSSEL1 (3.5" 720 KB) | 0 | 1 |

TABLE 5-7. PS/2 SUPPORT SEQUENCE

Bit 6 - DI/O, Data Input

DI/O indicates the direction of the data transfer between the FDC and the processor.

DI/O = 0 -

Transfer is from the processor to the Data Register.

DI/O = 1 -

Transfer is from the Data Register to the processor.

Bit 5 - EXM

EXM operates only during the Execution phase in non-DMA mode.

 $\mathsf{EXM} = 0$ -

Execution Phase has ended and the Results Phase has started.

EXM = 1 -

Performing Execution Phase in non-DMA mode.

Bit 4 - CD, Floppy Disk Controller Busy

CB = 0 -

The FDC is not busy.

CB = 1 -

A Read or Write Command is in progress. The FDC will not accept any other command.

Bit 3 - D3B, Floppy Disk Drive 3 Busy

D3B = 0 -

Floppy Drive 3 is not in Seek Mode.

D3B = 1 -

Floppy Drive 3 is in Seek Mode. If the Floppy Drive is in the Seek Mode, the FDC will not Read or Write commands.

Bit 2 - D2B, Floppy Disk Drive 2 Busy

D2B = 0 -

Floppy Drive 2 is not in Seek Mode.

D2B = 1 -

Floppy Drive 2 is in Seek Mode. If the Floppy Drive is in the Seek Mode, the FDC will not Read or Write commands.

Bit 1 - D1B, Floppy Disk Drive 1 Busy

D1B = 0 -

Floppy Drive 1 is not in Seek Mode.

Floppy Drive 1 is in Seek Mode. If the Floppy Drive is in the Seek Mode, the FDC will not Read or Write commands.

Bit 0 - D0B, Floppy Disk Drive 0 Busy

D0B = 0 -

Floppy Drive 0 is not in Seek Mode.

D0B = 1 -

Floppy Drive 0 is in Seek Mode. If the Floppy Drive is in the Seek Mode, the FDC will not Read or Write commands.

5

5.3.4.3 Overrun Error Status Reporting

The WD76C20 has the capability to detect and flag data overruns during DMA operations. This situation may occur, for example, when a floppy operation, DRAM refresh, and DMA channel 2 transfer occur simultaneously. Should a data overrun occur, D4 (OR) in Status Register 1 (SR1) will be set.

Versions of the WD76C20 which contain this feature can be distinguished easily by reading RTC RAM location 66H after reset. If the device contains the overrun flag feature, the LSB location 66H is 1. In these devices, 66H is read only.

Address 66 - Read only

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|---|---|---|---|---|---|------|
| | | | | | | | Flag |
| | | | | | | | |

Signal Name

Default At Reset

Bit 01

Bits 7-1 - Not defined

Bit 0 - Flag, Overrun Flag

Flag = 0 -

There is no overrun flag feature supported by this version of the WD76C20 device.

Flag = 1 -

The overrun flag feature is supported by this version of the WD76C20 device.

5.3.5 Status Registers

Address 3F4, A0 = 1, $\overline{CS} = 0$, $\overline{IOR} = 0$

There are four read only status registers that are part of the Floppy result phase and contain a variety of status information. They can only be accessed after the execution phase and must be read sequentially, starting with SR0 and going through SR3.

These four status registers are explained on the following pages.

5.3.5.1 Status Register 0

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|---|----|----|----|----|-----|-----|
| ŀ | С | SE | EC | NR | HS | US1 | US0 |
| | | | | | | | |

| Signal | Default |
|-------------|----------|
| Name | At Reset |
| All signals | 0 |

Bits 7 - 6 - IC, Interrupt Code

IC

- 76
- 0 0 Normal termination of command was completed and properly executed
- 0 1 Abnormal termination of the command (AT). Execution was started but was not successfully completed
- 1 0 Invalid command issue (IC). Issued command was never started
- 1 1 Not defined

Bit 5 - SE, Seek End

SE = 0 -

The FDC has not completed the SEEK command.

SE = 1 -

The FDC has completed the SEEK command.

Bit 4 - EC, Equipment Check

EC = 0 -

Track 0 signal occurred within 77 step pulses per Recalibrate Command.

EC = 1 -

Track 0 signal failed to occur after 77 step pulses per Recalibrate Command and set this flag.

Bit 3 - NR, Not Ready

NR = 0 -

Drive is ready. This is always assumed to be logic 0.

Bit 2 - HS, Head Select

This flag is used to indicate the state of the head at interrupt.

Bit 1 - US1, Unit Select 1

This flag is used to indicate a Drive Unit Number at interrupt.

Bit 0 - USO, Unit Select 0

This flag is used to indicate a Drive Unit Number at interrupt.

5.3.5.2 Status Register 1

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----|---|----|----|---|----|----|----|
| EN | 0 | DE | OR | 0 | ND | NW | MA |
| | | | | | | | |

| a | |
|----------|----------|
| Signal | Default |
| Name | At Reset |
| | 0 |

All signals0

Bit 7 - EN, End of Cylinder

EN = 1 -When the FDC tries to access a sector beyond the final sector of a cylinder, this flag is set.

Bit 6 - Not used. This bit is always low.

Bit 5 - DE, Data Error

DE = 1 -

The FDC has detected a Cyclic Redundancy Check (CRC) error in either the ID field or the data field and set this flag.

Bit 4 - OR, Overrun

OR = 0 -

The FDC was serviced by the Host during data transfers within a specified time interval.

OR = 1 -

The FDC was not serviced by the Host during data transfers within a specified time interval and this flag was set.

Bit 3 - Not used. This bit is always low.

Bit 2 - ND, No Data

When this bit is high, it can indicate one of several problems with FDC tracking or reading.

ND = 0 -

This flag is not set.

ND = 1 -

During execution of READ DATA, WRITE DELTED DATA, or SCAN, the FDC could not find the section specified in the Internal Data Register (IDR) and this flag was set.

During execution of the READ ID command, the FDC could not read the ID field without an error and this flag was set.

During execution of the READ A TRACK command, the starting sector could not be found and this flag was set.

Bit 1 - NW, Not Writeable

NW = 0 -

This flag is not set.

NW = 1 -

During execution of WRITE DATA, WRITE DELETED DATA, or FORMAT A TRACK, the FDC detected a WP from the Floppy Disk Drive and this flag was set.

Bit 0 - MA, Missing Address Mark

MA = 0 -

This flag is not set.

MA = 1 -

If the FDC cannot detect the ID Address Mark after encountering the index hole twice, then this flag is set.

If the FDC cannot detect the Data Address Mark or Deleted Data Address Mark, this flag is set. At the same time, the Missing Address Mark in the data field (MD) of Status Register 2 is set.

5.3.5.3 Status Register 2

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|----|----|----|----|----|----|----|
| 0 | СМ | DD | wc | SH | SN | BC | MD |
| | 1 | | | Í | | | |

Signal Name

Default At Reset

All signals0

Bit 7 - Not used. This bit is always low.

Bit 6 - CM, Control Mark

This flag is not set.

CM = 1 -

During execution of the READ DATA or SCAN command, the FDC encountered a section that contained a Deleted Data Address Mark and this flag was set.

Bit 5 - DD, Data Error

DD = 0 -

FDC detected no CRC error in the data field.

DD = 1 -

FDC detected a CRC error in the data field and set this flag.

Bit 4 - WC, Wrong Cylinder

This bit is related to the ND bit.

WC = 0 -

This flag is not set.

WC = 1 -

When the contents of Cylinder (C) on the medium is different from that stored in the IDR, this flag is set.

Bit 3 - SH, Scan Equal

SH = 0 -

During execution of the SCAN command, the condition of equal is not satisfied.

SH = 1 -

During execution of the SCAN command, the condition of equal is satisfied and this flag is set.

Bit 2 - SN, Scan Not

$$SN = 0$$
 -

This flag is not set.

SN = 1 -

The FDC cannot find a sector on the cylinder meeting the condition of SCAN and this flag is set.

Bit 1 - BC, Bad Cylinder

This bit is related to the ND bit.

BC = 0 -

This flag is not set.

BC = 1 -

When the contents of C on the medium does not agree with the IDR and the contents of C is FF, this flag is set.

Bit 0 - MD, Missing Address Mark In Data Field

MD = 0 -

This flag is not set.

MA = 1 -

When data is read from the medium, if the FDC cannot detect a Data Address Mark or Deleted Data Address Mark, then this flag is set.

5.3.5.4 Status Register 3

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|----|----|----|----|----|-----|-----|
| 0 | WP | RY | TO | WP | HS | US1 | US0 |
| | | | | | | | |

| Signal Name | Default At Reset |
|----------------|---------------------|
| Bit 7 | 0 |
| WP | 1 |
| RY | 1 |
| ΤΟ | 0 |
| WP | 1 |
| HS | 0 |
| US1 | 0 |
| US0 | 0 |

Bit 7 - Not used. This bit is always low.

This differs from the NEC765.

Bit 6 - WP, WRITE PROTECTED

This bit is used to indicate the status of the \overline{WP} signal from the Floppy Disk Drive.

$$\overline{WP} = 0 - WP$$
 is asserted.

 $\overline{WP} = 1 - WP$ is not asserted.

Bit 5 - RY, Ready

This differs from the 765 standard.

RY = 1 -

This bit is always set to this value because the drive is presumed to be ready.

Bit 4 - TO, Track 0

This bit is used to indicate the status of the Track 0 signal from the FDD.

T0 = 0 -

T0 is not asserted.

T0 = 1 -

T0 is asserted.

Bit 3 - WP, WRITE PROTECTED

This bit is used by the WD76C20 to indicate the status of the WRITE PROTECTED signal from the FDD.

$$\overline{WP} = 0 - WP$$
 is asset

WP is asserted.

WP = 1 - WP is not asserted

Bit 2 - HS, Head Select

This bit is used to indicate the status of the Side Select signal to the FDD.

HS = 0 -

Side Select signal is not asserted.

HS = 1 -

Side Select signal asserted.

Bit 1 - US1, Unit Select 1

This bit is used to indicate the status of the Unit Select 1 signal to the FDD.
US1 = 0 -

Unit Select 1 signal is not asserted.

US1 = 1 -

Unit Select 1 signal is asserted.

Bit 0 - US2, Unit Select 2

This bit is used to indicate the status of the Unit Select 2 signal to the FDD.

US0 = 0 -

Unit Select 2 signal is not asserted.

US0 = 1 -

Unit Select 2 signal is asserted.

5.3.6 Data Register

The eight-bit Data Register is a Read/Write register controlling the flow of data that stores data, commands, parameters, and FDD status information. Data bytes are read out of, or written into, the Data Register in order to program or obtain results after a particular command.

The Data Register is selectively decoded by four signals – A0, RD, \overline{WR} , and \overline{FDCS} (CSL code 09) – as shown below.

| A 0 | RD | WR | FDCS | FUNCTION |
|------------|----|----|------|------------------------|
| 1 | 0 | 1 | 0 | Read Data Register |
| 1 | 1 | 0 | 0 | Wrote to Data Register |

TABLE 5-8. DATA REGISTER DECODE

Address 3F5 - Read and Write

Two bits within the MSR (address 3F4), RQM (bit 7) and DIO (bit 6) are used to perform the handshaking function and transfer data between the Data Register and the processor. All disk data transfer goes through this register. Once the FDC enters the command execution phase, it clears the Data Register of all data to ensure that no invalid data is transferred.



6.0 IDE DRIVE INTERFACE

This section discusses the components of the WD76C20 that control and oversee the function of the Integrated Drive Electronics (IDE) interface logic. While most of the traditional hard disk controller functions reside on the drive itself, the chip set must still interact at several points with the drive in order to coordinate the transmission of data and address information across the bus.

6.1 IDE DRIVE SIGNAL LOGIC

The WD76C20 provides multiplexing and data path buffering for IDE drive data. Internally, these functions are achieved using pads DB7 and IDED7.

6.2 CHIP SELECT

IDE drive support is handled by the WD76C10 and WD76C20 cooperatively, utilizing chip select logic. Table 6-1 provides a table of the chip select assignments integral to the IDE support. For more information on Chip Select Logic, refer to Section 4.

6.3 IDE/FDD DRIVE SELECTION

The WD76C20 determines whether the IDE drive or the FDD is using the bus. When the CSL decodes for 0A, any reads or writes to address 3F7 or 377 indicate that the Floppy Disk Drive is chosen. When the CSL decodes for 0B, reads to 3F7 indicate the FDD and writes specify the IDE drive. When the CSL decodes for 0C, reads and writes are always selected for a hard disk drive at addresses 1F0 through 1F7 and 170 through 177. When the CSL decodes for 0D, reads and writes are always selected for the hard disk (IDE drive only), at addresses 3F6 - 3F7 and 376 - 377.

6.4 IDE READ/WRITE

The read or write status of the IDE drive is determined by the IDED7 signal which provides a data path for bit 7 between the host and the IDE drive interface. IDED7 becomes an output, writing data from the host to the drive, when IOW is driven low. IDED7 is an input signal, reading data from the drive to the host, when IOR is low.

The exception to this rule is when the chip is reading from address 3F7. As previously explained, when IOR is detected at this location, the floppy DCHG status is output on the host data bus pin DB7.

6.5 IDE DRIVE SELECT

The WD76C20 can support a maximum of two drives. Drive selection is determined by the CSIDE0 and CSIDE1 signals. Normally, when CSIDE0 is driven low, it indicates that drive 0 is on the bus; when CSIDE1 is driven low, this indicates that drive 1 is on the bus. Both of these signals are activated through a decode in the CSL and are asserted in conjunction with either IDEDENL or both IDEDENH and IDEDENL. CSL 0B decodes for CSIDE1 and 0C decodes for CSIDE0.

6.6 DATA PATH SELECT

The IDE data path can either be 8- or 16-bits wide. Recognition of this width is made possible using the IDEDENL and IDEDENH signals. When asserted low, IDEDENL and IDEDENH indicate a 16-bit path exists. IDEDENH is asserted only when A0 is driven low and the CSL has decoded for 0C. IDEDENL is asserted when CSL is decoded for 0C or 0D.

| PORT | I/O ADDRESS | CS# | FUNCTION |
|------------------------------|--|-----|--|
| Floppy/Hard Disk Chip Select | 3F7 377 | 0B | Primary Address Secondary Address (Floppy Enabled, HD Enabled) |
| Hard Disk Chip Select | 1F0, 1F1 - 1F7 170, 171 - 177 | 0C | Primary Address Secondary Address |
| IDE Hard Disk Chip Select | 3F6, 3F7 ¹ 376, 377 ¹ | 0D | Primary Address, IDE Mode Only Seconary Address, IDE Mode Only |

TABLE 6-1. IDE CHIP SELECT ASSIGNMENTS

¹ IDE Hard Disk enabled, floppy disabled.

7.0 REAL TIME CLOCK

This section describes the Real Time Clock and its associated registers. A block diagram of the RTC is shown in Figure 7-1.



FIGURE 7-1. RTC BLOCK DIAGRAM

Ten SRAM data registers (Registers 00-09) contain all the calendar/clock/alarm information with the RTC crystal-controlled oscillator and frequency divider providing the appropriate timing updates to keep them accurate. Control and status information for the RTC is contained in Registers A-D of the SRAM. Remaining SRAM registers, with a total capacity of 114 bytes, are available to the user.

Read and/or write access to the SRAM (control/status, calendar/clock/alarm, and general purpose registers) is through the RTC bus interface. This interface gets signals from the 76C20 Bus Interface and Chip Select Logic functions and appropriately buffers bits D0-D7 between the 76C20 internal bus and the RTC internal bus accessing the SRAM. Calendar/clock/alarm information is processed through Update Logic that:

- Increments calendar/clock counts based on "ticks" received from the Frequency Divider,
- Attends to Daylight/Standard Time and Leap Year adjustments, and
- Formats/deformats the information as straight binary or binary coded decimal data, as selected.

Input power to the RTC component is from the VBAT pin. Switching from System VDD to battery power is accomplished through two diodes as shown in Figure 7-1.



FIGURE 7-2. VBAT EXTERNAL SUPPORT

7.1 TIME BASE OSCILLATOR CIRCUIT

The oscillator that provides the time base for the RTC requires the external circuit shown in Figure 7-2 and the values listed in Table 7-1. The crystal used in parallel with the on-chip oscillator should be an AT-cut crystal with a 32.768 KHz resonant frequency as shown in Figure 7-3, using signals listed in Table 7-2. When in battery backup mode, this circuit is still active, providing the rest of the RTC with a valid time base.



FIGURE 7-3. RTC CRYSTAL EXTERNAL CIRCUITRY



FIGURE 7-4. RTC CRYSTAL PARAMETERS

7.2 POWER SWITCH

This functional block is used to detect when the system power is shutting down and the RTC needs to go into battery backup mode. In the event of a full chip power-down without a battery backup, the VRT bit of register D will be reset to zero, indicating that the contents of the SRAM and RTC operational registers are not guaranteed. In order to reset the bit, register D must be read after a full power-up.

7.3 BUS INTERFACE

The RTC Bus Interface block is used to access the internal bus for the WD76C20. Protocol is maintained between the BIL block (Bus Interface Logic) and the RTC Bus Interface. The BIL block generates the RD and WR strobes, and the CS signals are decoded from the external bus by the Chip Select Logic.

7.4 CLOCK DIVIDER

This functional block uses clock divider logic to split the 32.768 KHz time base down to a 1 Hz signal that can be used by the timekeeping blocks. It also provides the periodic interrupt block with access to all stages of the division.

7.5 PERIODIC INTERRUPT

This functional block has access to the various stages of the Clock Divider. Using these signals under the direction of register A, an RTCIRQ pulse can be generated periodically for the processor, varying from once every 122 μ S to once every 500 ms. The Periodic Interrupt function is enabled by the PIE bit in register B.

7.6 BCD/BINARY INCREMENT & CLOCK/CALENDAR UPDATE

This dual purpose logic block is used to increment and update the 10 timing registers and to check for the existence of an alarm condition. Several register bits are used to control this block, preventing contention between a processor seeking access to the information registers and the occurrence of an update cycle.

7.7 OPERATIONAL REGISTERS

Shown in Figure 7-2 is a memory map of the RTC, SRAM and operational registers. Under normal conditions all these registers are Read/Write except:

- Registers C and D are Read Only.
- Bit 7 of register A is Read Only.
- The high order bit of the seconds byte is Read Only.

7.7.1 Setting Correct Time

Writing the correct time to the RTC is done using this sequence:

- 1. Program the SET bit in register B to 1 and the Data Mode bit (DM) of Register B to the appropriate level.
- Load the 10 bytes representing the current time and alarm status from the host into the RTC by addressing the appropriate memory locations and performing a normal I/O Write operation.
- 3. After all 10 timing bytes and the DM bit have been written to the RTC, the SET bit should be cleared.

After this, the DM bit cannot be changed without reinitializing all 10 registers.



FIGURE 7-5. RTC ADDRESS MAP

1/-

| ADDRESS | FUNCTION | RANGE | | | |
|---------|--|------------------|------------------------------|-------------------------|--|
| | | DECIMAL | BINARY | BCD DATA | |
| 00 | SECONDS | 0 - 59 | 00 - 3B | 00 - 59 | |
| 01 | SECONDS ALARM | 0 - 59 | 00 - 3B | 00 - 59 | |
| 02 | MINUTES | 0 - 59 | 00 - 3B | 00 - 59 | |
| 03 | MINUTES ALARM | 0 - 59 | 00 - 3B | 00 - 59 | |
| 04 | HOURS - 12 HOUR MODE HOURS - 24 HOUR MODE | 1 - 12 0 - 23 | 01-0C am,81-8C pm 00 - 17 | 01-12, 81-92 00 - 23 | |
| 05 | HOURS ALARM - 12 HOUR MODE HOURS ALARM - 24 HOUR MODE | 1 - 12 0 - 23 | 01-0C am,81-8C pm 00 - 17 | 01-12, 81-92 00 - 23 | |
| 06 | DAY OF THE WEEK (SUNDAY = 1 etc.) | 1 - 7 | 01 - 17 | 01 - 17 | |
| 07 | DATE | 1 - 31 | 01 - 1F | 01 - 31 | |
| 08 | MONTH | 1 - 12 | 01 - 0C | 01 - 12 | |
| 09 | YEAR | 0 - 99 | 00 - 63 | 00 - 99 | |

TABLE 7-1. RTC DATA MODES

Table 7-1 shows the Binary and BCD formats of the time, calendar and alarm locations. When the 12-hour format is selected, the high order bit of the hours byte represents AM when it is 0, and PM when it is 1. Once a second, the 10 bytes are updated and checked for alarm conditions. If a Host Read of the time occurs during an update, the hours, minutes, and seconds may not agree. Methods to avoid this possibility are covered later.

7.7.2 Setting Alarm Intervals

Alarms can be set to interrupt the Host in a variety of ways, designating intervals ranging from once a second to once a day. To set periodicity: write don't care bytes (any value from C0 to FF) into the appropriate alarm registers. In this way, an alarm scheduled to interrupt the Host only once a day would have all alarm registers programmed to the proper values. An alarm scheduled to go off once an hour would have a don't care value in the hour register. One scheduled to go off every minute would have don't care values programmed into hours and minutes. An alarm will go off every second if all three registers are programmed to don't cares.

7.7.3 RTC Register A

Address 0A - Bit 7 Read only, Bits 6-0 Read/Write

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|-----|-----|-----|-----|-----|-----|-----|
| UIP | DV2 | DV1 | DV0 | RS3 | RS2 | RS1 | RS0 |
| | | | | | | | |

| Signal Name | Default At Reset |
|----------------|---------------------|
| UIP | None |
| DV2-0 | None |
| RS3-0 | None |

Bit 7 - UIP, Update In Progress

Used by the Host to determine when updates are not going to occur.

UIP = 0 -

The Host can assume that a transfer is not going to happen for at least another 244 μ s, during which time registers 9 through 0 are fully available. Writing 1 to the SET bit (Register B, bit 7) inhibits any further updates and clears the UIP bit.

UIP = 1 -

An update is in progress during which time registers 9 through 0 are not available.

Bits 6-4 - DV2-0, Oscillator Control 2-0

DV2, DV1 and DV0 enable and disable the oscillator for use during product shipping. The code 010 will turn the oscillator on and start dividing.

Bits 6-4 - DV2-0, Oscillator Control 2-0

RS3, RS2, RS1 and RS0 are used to select the periodic interrupt rate as shown in Table 7-2. Once the rate is selected, use the PIE bit (Register B, bit 6) to enable the interrupt. Functionally, these pins are decoded to select which spot on the divider chain should be tapped in order to generate interrupts.

| RE | GISTI | ERAE | BITS | PERIODIC |
|-----|-------|------|------|----------------|
| RS3 | RS2 | RS1 | RS0 | INTERRUPT RATE |
| -0 | 0 | 0 | 0 | None |
| 0 | 0 | 0 | 1 | 3.90625 ms |
| 0 | 0 | 1 | 0 | 7.8125 ms |
| 0 | 0 | 1 | 1 | 122.070 μs |
| 0 | 1 | 0 | 0 | 244.141 μs |
| 0 | 1 | 0 | 1 | 488.281 μs |
| 0 | 1 | 1 | 0 | 976.5625 μs |
| 0 | 1 | 1 | 1 | 1.953125 ms |
| ·1 | 0 | 0 | 0 | 3.90625 ms |
| 1 | 0 | 0 | 1 | 7.8125 ms |
| 1 | 0 | 1 | 0 | 15.625 ms |
| 1 | 0 | 1 | 1 | 31.25 ms |
| 1 | 1 | 0 | 0 | 125 ms |
| 1 | 1 | 0 | 1 | 250 ms |
| 1 | 1 | 1 | 0 | 500 ms |
| 1 | 1 | 1 | 1 | |

TABLE 7-2. RTC PERIODIC INTERRUPT RATE DECODER

7.7.4 RTC Register B

Address 0B - Read and Write

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|-----|-----|-----|---|----|-------|-----|
| SET | PIE | AIE | UIE | 0 | DM | 24/12 | DSE |
| , | | | | | | | |

| Signal Name | Default At Reset |
|----------------|---------------------|
| SET | 0 |
| PIE | 0 |
| AIE | 0 |
| UIE | |
| Bit 3 | |
| DM | |
| 24/12 | |
| DSE | None |

Bit 7 - SET, Write to registers 9-0 in progress

SET = 0 -

Normal operation.

SET = 1 -

A Write to registers 9 through 0 can proceed without the possibility of an update cycle occurring part way through.

Bit 6 - PIE, Period Interrupt Enable

PIE = 0 -

Normal operation.

```
PIE = 1 -
```

The Host is interrupted whenever the Periodic Interrupt Flag (PIF at Register C, bit 6) is set to 1.

Bit 5 - AIE, Alarm Interrupt Enable

AIE = 0 -

The Host is not interrupted as a result of the AF.

AIE = 1 -

The Host is interrupted whenever the Alarm Flag (AF at Register C, bit 5) is set to 1.

Bit 4 - UIE, Update Interrupt Enable

UIE = 0 -

The Host is not interrupted as a result of the UF.

UIE = 1 -

The Host is interrupted whenever the Update Flag (UF at Register C, bit 4) is set to 1.

5

Bit 3 - Reserved, should be set to zero (default state at reset)

DM, Data Mode

The DATA Mode control bit sets and indicates whether the time is stored in binary or BCD format.

DM = 0 -

Binary coded decimal data.

DM = 1 -

Binary data.

Bit 1 - 24/12, 24- or 12-hour format

24/12 = 0 -

The time is set to a 12-hour AM, PM format.

24/12 = 1 -

The time is set to a 24-hour format.

Bit 0 - DSE, Daylight Savings Enable

The Daylight Savings Enable bit allows the RTC to perform adjustments required to maintain daylight savings: on the first Sunday in April, the time increments from 1:59:59 AM to 3:00:00 AM, and on the last Sunday in October at 1:59:59 AM, it changes to 1:00:00 AM

DSE = 0 -

Daylight savings time is not enabled.

DSE = 1 -

Daylight savings time is enabled.

7.7.5 RTC Register C

Address 0C - Read only

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|-----|-----|----|---|-----|-------|---|
| IRQF | PIF | AIF | UP | | Res | erved | |
| | | | | | | | |

| Signal Name | Default At Reset |
|----------------|---------------------|
| IRQF | 0 |
| PIF | 0 |
| AIF | |
| UF | |
| Bits3-0 | 0 |

Bit 7 - IRQF, Interrupt Request Flag

IRQF = 0 -

The RTC is not issuing a Host service interrupt request.

SET = 1 -

The RTC is issuing a Host service interrupt request. The Boolean equation for the flag is:

Bit 6 - PIF, Period Interrupt Flag

The PIF bit is independent of the PIE bit, but the PIE bit still controls whether or not an RTCIRQ pulse is generated.

PIF = 0 -

The divider tap determined by the decoded RSX lines did not change state.

PIF = 1 -

The divider tap determined by the decoded RSX lines changed state. The bit is cleared by reading Register C or resetting the WD76C20.

Bit 5 - AIF, Alarm Interrupt Flag

AIF = 0 -

An alarm condition has not occurred.

AIF = 1 -

An alarm condition has occurred, either because of a timing match or "don't care" conditions. AIF is cleared by reading Register C or resetting the WD76C20.

Bit 4 - UF, Update Ended Interrupt Flag

UIE = 0 -

UF is reset during each update cycle.

UIE = 1 -

UF is set after each update cycle.

Bit 3-0 - Reserved, 0 default at reset

7.7.6 RTC Register D

Address 0D - Read only

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|-----|-----|----|-----|------|-------|-----|
| IRQF | PIF | AIF | UP | | Rese | erved | |
| | | | | ID3 | ID2 | ID1 | ID0 |

| Signal Name | Default At Reset |
|----------------|---------------------|
| VRT | None |
| Bits6-4 | 0 |
| ID3-0 | None |

Bit 7 - VRT, Valid RAM and Time

The RTC uses Valid RAM and Time to indicate the possibility of corruption in the SRAM memory locations.

VRT = 0 -

The time and calendar are not valid. An interrupt in the power occurred during which neither VBAT or VDD provided sufficient voltage.

VRT = 1 -

The time and calendar are valid. An interrupt in power either did not occur, or VBAT or VDD provided sufficient voltage.

Bits 6-4 - Not used, state is ignored

Bit 3-0 - ID3-0, Revision ID Code

ID3, ID2, ID1, and ID0 are used to indicate the device ID code. This code identifies the chip during board-level testing.



8.0 POWER MANAGEMENT: SUSPEND/RESUME LOGIC

Suspend/Resume Logic is used in conjunction with the RTC time base to provide a 14.318 MHz clock output to the WD76C10. This can switch to a 32.768 KHz clock during the Suspend mode. While in Suspend mode, the WD76C20 typically draws less than 2 mA.

The Suspend/Resume Logic also provides the external DRAM refresh signal, PDREF, that pulses active low once every 15.26 μ S. This logic also supports a latched signal that causes CSSERA, CSSERB and CSPAR0 to remain low during Suspend mode, signaling the WD76C30 to disable the 48 MHz crystal.

Like several other functions discussed in this databook, the Suspend/Resume function is supported by the entire chip set, especially the WD76C20 and WD76C30. In the discussion that follows, much of the material can also apply to other members of the chip set. To see the interconnection of chips during this process, refer to Figure 8-x.

8.1 OVERVIEW

The WD7600's power management saves power whenever possible without degrading the system's performance. Whenever the system perceives itself as not doing anything "useful," it powers down. This both slows the clock speed and cuts down on power consumption. The full power-down sequence is called system Suspend. The power-up sequence from system Suspend is called Resume.

8.1.1 Suspending the System

Suspend is initiated by a change in the state of certain Power Management Control (PMC) input(s). This change can either be programmed to generate a NMI or a Local Attention. If a PMC input is programmed to cause a Local Attention, the Local Attention signal has to be tied to an IRQ level. Once tied to interrupts, it can be determined when a system is performing an "idle" task. When it is known that the system is performing such a task, the processor can be safely powered down. The processor is then awakened on the next unmasked DRQ, IRQ, or NMI.

Once the processor is halted, it is awakened by an IRQ, which means that it will come out of power down on every IRQ0 once every 55 μ s.

Several conditions are used by the processor to confirm an "idle" state. These are:

- Low battery condition
- External switch tied to a PMC interrupt enable that generates an IRQ
- Software-initiated suspend corresponding to a hardware interrupt (for example, an INT77H for IRQ15H)
- Watchdog timer generates a PMC interrupt to the WD76C10 (which in turn generates an IRQ) whenever it recognizes it is not being used.

Any of the preceding reasons are valid for ascertaining that the system is idle. The following is a general description of the Suspend sequence:

1. Any change in PMC input signals the WD76C10 to generate a Local Attention which is tied to an IRQ leading to the processor.

The processor vectors to the power-down routine and the processor saves its internal states and the states of all peripherals attached to it that are to power down.

The processor saves the states into a protected area of the system DRAM (similar to the shadowed BIOS). If the entire AT bus is to be powered down, the processor writes to the BUS POWER DOWN ENABLE bit in the WD76C10.

- 2. The power down routine (in a loadable driver) writes to the full-power-down bit in the WD76C10 which enables the power-down sequence. The WD76C10 switches to sampling of the PMC inputs with the 14.318 MHz clock instead of the AT BUS clock.
- 3. The processor then writes to an I/O register in the WD76C10 that switches a PMC output connected to the PWRDN input pin of the WD90C20. On assertion of the PWRDN signal, the VGA controller enters the Power Down mode which refreshes the video DRAM via the AT BUS REFRESH signal. This is done so that the PIXCLK clock generator can later be powered down and the VGA controller can continue refresh. CAS before RAS refresh is the preferred way of refreshing the DRAMs because it allows lower power operation



without the generation of a DRAM refresh address.

4. The processor then writes to the KILL 48 MHz register which sends a CSL address code of 15H to the WD7600 encoded Chip Select Bus (ENCSBUS). The WD76C20 decodes the 15H (qualified by an IOW) and disables its 16 MHz oscillator, errorlessly switches the 14.318 MHz oscillator signal to a 32 KHz, 50% duty cycle signal, then disables the 14.318 MHz oscillator. The WD76C20 also asserts the CSSERA, CSSERB, and CSPAR signals simultaneously which signals the WD76C30 to disable its 48 MHz oscillator. When this oscillator is disabled. the AT BUS CLOCK, KEYBOARD CLOCK, and 80287 CLOCK are disabled. The processor executes a halt instruction and the WD76C10 detects the halt status from the processor and switches from the AT compatible refresh to the PDREF controlled refresh. The WD76C10 then switches the AT bus compatible REFRESH output signal to mimic the PDREF input signal.

The PDREF input is a CMOS level clock signal that has a 124 μ s period and a low going pulse of 200 ns to 1 μ s. This signal is always active and should be adequate for refreshing low power DRAMs. This signal is generated by the WD76C20.

5. On detecting that the 14.318 MHz clock has been changed to 32 KHz, the WD76C10 tristates all outputs except the PMC controls, DRAM controls, RAD bus, and AT bus REFRESH signal. The CPURES signal is asserted and then tri-stated and is pulled high through a 200K pull-up resistor. All inputs except RSTIN, CLK14, and the PMC are ignored, and all circuitry except the PMC and refresh logic is stopped.

The power is now turned off to the CPU, PIXCLK, BUS, etc. by the assertion of a PMC output from the WD76C10.

Figure 8-1 illustrates the interconnected concepts of Suspend, Resume, and Sleep Mode cycles.

8.1.2 Resuming the System

Resume is initiated by changes to PMC input(s) similar to the Suspend mode.

- 1. The WD76C10 samples the PMC inputs at 32 KHz. When it detects a change of any enabled PMC inputs, PMC outputs switch and power up the processor, bus, and so on. After 1 ms (timed by the 32 KHz clock input), the WD76C10 samples the processor-power-good PMC input. When this is active, the CPURES is driven high and the rest of the WD76C10 control outputs are driven to their correct states. If the BUS POWER DOWN bit is enabled, a BUS RESET is issued also.
- 2. Once the chip detects the power-good signal, the WD76C10 performs a write to the ENABLE 48 HMz register which sends a CSL address code of 16H on the ENCSBUS.
- 3. The WD76C20 receives the 16H address code, enables the 16 MHz and 14.318 MHz oscillators, and deasserts the CSSERA, CSSERB, and CSPAR signals. After approximately 20 ms (stabilizing time for the oscillators), the WD76C20 switches the OSC 32 KHz signal to 14.318 MHz.
- 4. The WD76C30 enables its 48 MHz oscillator on the deassertion of its CSSERA, CSSERB, and CSPAR input signals.
- 5. When the WD76C10 detects that the 32 KHz has been switched to 14.318 MHz, it switches the PMC sampling to the AT BUS CLOCK. The WD76C10 then switches from PDREF- controlled refresh to the AT-compatible refresh. The WD76C10 also switches the AT bus REFRESH sign from PDREF input to AT-compatible refresh rate. The WD76C10 deasserts the CPURESET signal and the processor comes out of reset and checks the shutdown status in the RTC RAM on the WD76C20. This tells the processor that it is coming out of full powerdown mode as opposed to a warm or cold boot. The processor then restores the states of the machine.
- The processor writes to the WD76C10 register that causes the WD76C10 to deassert its PMC output. This output is connected to the PWRDN input of the WD90C20 signaling the WD90C20 to come out of the power down mode.

Figure 8-2 illustrates how the WD7600 chip set shares the Suspend/Resume/Sleep Mode duties.

5



1/2



FIGURE 8-2. FULL POWER-DOWN MODE SYSTEM BLOCK DIAGRAM

8.2 PDREF

The PDREF is an external DRAM refresh line used to support the WD76C10 when it goes into Suspend/Resume mode. During Suspend/Resume mode, this pad provides a 1.0 μ s pulse once every 15.26 μ s (during a 50% duty cycle). This pulse is used to maintain the DRAM integrity with as little power as possible.

8.3 14 MHZ CRYSTAL SPECIFICATIONS

The 14.318 MHz crystal oscillator associated with the Suspend/Resume Logic is shown in Figure 8-3. This timing is maintained through the MX14 and $\overline{\text{MX14}}$ pins. $\underline{\text{MX14}}$ is the input pin for the 14.318 oscillator and $\overline{\text{MX14}}$ is the output pin for the oscillator.







8.4 PIN STATES DURING POWER DOWN

Table 8-1 shows what happens to the pins during power-down.

| PIN NO. | SIGNAL NAME | INPUT/ OUTPUT | PD IN | OPT1 OUT | PD IN | OPT2 OUT | SUSPEN IN | D MODE OUT |
|------------|----------------|----------------------------|----------|-------------|----------|---------------|--------------|---------------|
| 1 | IDEDENH | OUTPUT | | 0 | | 0 | | Z |
| 2 | VSS | VSS | | | | · | | |
| 3 | FX1 | OUTPUT | | Z | | Z | | Z |
| 4 | FX1 | INPUT | IH | | IH | | IH . | |
| 5 | VDD | VDD | | | | • | | |
| 6 | FCLK2 | INPUT | IH | | IH | | IH | |
| 7 | RDD | SCH INPUT | IH | | IH | 1. 1. a. i | IH | |
| 8 | DMA | BIDIRECT (input unused) | IH | Z*** | IH | Z*** | ін | Z |
| 9 | FIRQ | BIDIRECT | ІН | Z*** | ін | Z*** | ІН | z |
| 10 | DCHG | SCH W/PULLUP | IH | 2 | IH | 2 | IH | 2 |
| 11 | PCVAL | SCH INPUT | IH | | IH | | IH | |
| 12 | DRV | BIDIRECT SCH | IH | Z | ін | z | IH | z |
| 12 | UNV | (W/PULLUP) | 10 | 2 | | 2 | | 2 |
| 13 | HS | OUTPUT | | Z | | Z | - | Z |
| 14 | WE | OUTPUT | | Z | | Z | | z |
| 15 | WD | OUTPUT | | Z | | Z | | Z |
| 16 | VSS | VSS | | | | | | |
| 17 | DIRC | OUTPUT | | Z | | Z | | Z |
| 18 | STEP | OUTPUT | | Z | | Z | | Z |
| 19 | DS0 | OUTPUT | | Z | | Z | | Z |
| 20 | DS1 | OUTPUT | | Z | | Z | | Z |
| 21 | DS2 | OUTPUT | | Z | | Z | | Z |
| 22 | DS3 | OUTPUT | | Z | | Z | | Z |
| 23 | MOO | OUTPUT | | Z | | Z | | Z |
| 24 | MO1 | OUTPUT | | Z | | Z | | Z |
| 25 | VSS | VSS | | | | | | |
| 26 | MO2 | OUTPUT | | Z | | Z | | Z |
| 27 | MO3 | OUTPUT | | Z | | Z | | Z |
| 28 | HDL | OUTPUT | | Z | | Z | | Z |
| 29 | RWC | OUTPUT | | Z | | Z | | Z |
| 30 | PWRDN | OUTPUT | | ОН | | ОН | | ОН |
| 31 | WP | INPUT | IH | | IH | | IH | |

TABLE 8-1. PIN STATES DURING POWER-DOWN

| PIN NO. | SIGNAL NAME | INPUT/ OUTPUT | PD OPT | | D OPT2 OUT | SUS | PEND MO | |
|------------|---------------------|------------------|-------------|----------|--------------------------------|---------|----------|-----|
| 32 | TROO | INPUT | ІН | | | IH | | |
| 33 | IDX | INPUT | IH | н | | IH | | |
| 34 | VSS | VSS | 111 | | | | | |
| 35 | *DB0 | BIDIRECT | 1 0 | | Ο | н | Z | |
| 36 | *DB1 | BIDIRECT | | | 0 | IH | Z | |
| 1 | 1 1 | BIDIRECT | | | | IH | Z | |
| 37 | *DB2 | | | | 0.0 | | Z | |
| 38 | *DB3 | BIDIRECT | 1 0 | | 0 | IH | | |
| 39 | *DB4 | BIDIRECT | 1 0 | | 0 | IH | Z | |
| 40 | *DB5 | BIDIRECT | 1 0 | | 0 | IH | Z | |
| 41 | *DB6 | BIDIRECT | 1 0 | | 0 | IH | Z | |
| 42 | *DB7 | BIDIRECT | 1 0 | 1 | 0 | н | Z | |
| 43 | IDED7 | BIDIRECT | 1 O | | 0 | IH | Z | - |
| 44 | VDD | VDD | | | | | | 1 |
| 45 | A0 | INPUT | 1 | 1 | | н | | |
| 46 | VSS | VSS | | | | | | |
| 47 | DACK | INPUT | 1 | 1 | | IH | | |
| 48 | IOR | INPUT | 1 | 1 | | IH | | |
| 49 | ĪOW | INPUT | 1 | | | н | | |
| 50 | CSEN | INPUT | 1 | 1 | an an Article An an Article | 1 | | |
| 51 | DACKEN | INPUT | 1 | 1 | | - 1 | | |
| 52 | DPH | INPUT | 1 | 1 | | 1 | | |
| 53 | DPL | INPUT | 1. 1 | 2 G L 16 | | 1.11.00 | | |
| 54 | RA10 | INPUT | 1 | 1 | | 1 | | |
| 55 | RA9 | INPUT | 1 | | | 1 | | |
| 56 | RA8 | INPUT | | 1 | | 1 | | |
| 57 | RESET | INPUT | 1 | 1 | | 1 | | |
| 58 | RCLR | INPUT | 1 | 1 | | ін | | |
| 59 | BALE | INPUT | | | | н | | |
| | | (W/ PULLUP) | | | | | | |
| 60 | RTCX | OUTPUT | 0 | | О | | 0 | |
| 61 | RTCX | INPUT | | | - | 1 | | |
| 62 | VBAT | VDD | | | | | | |
| 63 | MX14 | INPUT | 1 | | | н | | . 1 |
| 64 | $\frac{MX14}{MX14}$ | OUTPUT | · 0 | | 0 | | Z | |
| 65 | VSS | VSS | | | ~ | | ~ | |
| 00 | | 400 | | | | | | |
| | | | | | | | | . 1 |
| | | | l | | | 1 | | |

TABLE 8-1. PIN STATES DURING POWER-DOWN (CONTINUED)

| PIN NO. | SIGNAL NAME | INPUT/ OUTPUT | PD IN | OPT1 OUT | PD IN | OPT2 OUT | SUSPE IN | ND MODE |
|------------|----------------|------------------|----------|-------------|----------|-------------|-------------|---------|
| 66 | PDREF | OUTPUT | | 0 | | 0 | | 0 |
| 67 | VDD | VDD | | | | | | |
| 68 | OSC | OUTPUT | | 0 | | 0 | | 0 |
| 69 | RTCIRQ | OUTPUT | | 0 | | 0 | | 0 |
| 70 | тс | OUTPUT | 1 | 0 | | 0 | | 0 |
| 71 | PRDY | INPUT | 1 | | 1 | | IH | |
| 72 | EMS | OUTPUT | | 0 | | 0 | | Z |
| 73 | PROGCS | OUTPUT | | 0 | | 0 | | Z |
| 74 | PCUW1 | OUTPUT | | 0 | | 0 | | 0 |
| 75 | PCUW0 | OUTPUT | 1 | 0 | | 0 | | 0 |
| 76 | NPCS | OUTPUT | | 0 | | 0 | | z |
| 77 | CS8042 | OUTPUT | | 0 | | 0 | | Z |
| 78 | ROMOE | OUTPUT | | 0 | | 0 | | Z |
| 79 | CSPAR0 | OUTPUT | | 0 | | 0 | | 0 |
| 80 | CSSERB | OUTPUT | | 0 | | 0 | | 0 |
| 81 | CSSERA | OUTPUT | | 0 | | 0 | | 0 |
| 82 | CSIDE1 | OUTPUT | | 0 | | 0 | | Z |
| 83 | CSIDE0 | OUTPUT | | 0 | | 0 | | Z |
| 84 | IDEDENL | OUTPUT | | 0 | | 0 | | Z |
| | | | | . | | | | |

TABLE 8-1. PIN STATES DURING POWER-DOWN (CONTINUED)

9.0 **SPECIFICATIONS**

9.1 MAXIMUM RATINGS

Absolute Maximum Ratings - All voltages referenced to VSS 7 0 1/-1 1000

| VCC | |
|----------------------------------|--|
| Voltage at any pin + 0.3 Volts | |
| Storage Temperature55°C to +70°C | |

9.1 DC OPERATING CHARACTERISTICS

TA=0°C (32°F) to 70°C (158°F) $VCC = 5V \pm 5\%$ CL =100 pf; Can =10 pf; Cinclk = 20 pf VIL/VOL referenced to 0.8V VIH/VOH referenced to 2.0V

CY specifies FX1 period

MCY specifies MCLK period, dependent on selected data rate

WCY specifies MCLK period, dependent on selected data rate

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|---------|---|------|-----------|-----------|
| VCC | +5V Supply | 4.75 | 5.25 | V |
| VBAT | Battery Backup Voltage | 2.6 | VDD | V |
| VIL | Input Low Voltage - Data Bus & XTOCS | | 0.8 | V |
| VIH | Input High Voltage - Data Bus & XTOCS | 2.0 | | V |
| VILT | Input Low Threshold - Schmitt Trigger | 0.8 | | v |
| VIHT | Input High Threshold - Schmitt Trigger | 1.7 | 2.0 | V |
| VHYS | Schmitt Trigger Hysteresis | 0.5 | | Vtypical |
| VOLAT | Output Low - DBus, FIRQ, DMA; IO=12.0 mA | | 0.4 | V |
| VOHAT | Output High - DBus, FIRQ, DMA; IO= -5.0 mA | 2.8 | | V |
| VOLHC | Output Low - Drive Interface IO=48 mA | | 0.4 | V |
| VOL | Output Low - All Others; IO=4.0 mA | | 0.4 | V |
| VOH | Output High - All Others; IO=400 uA | 2.8 | 4 (A) | V |
| ILUL | Latch Up Current Low | 40 | | mA |
| ILUH | Latch Up Current High | -40 | | mA |
| ILL | Leakage Current Low | | 10 | uA |
| ILH | Leakage Current High | | -10 | uA |
| ICC | Supply Current - 100 uA source loads | | 70 | mA |
| ICC | Supply Current - 5 mA source loads | | 140 | mA |
| ICCPDM1 | Supply current in power down mode ¹ (Option 1) | | 200 | uAtypical |
| ICCPDM2 | Supply current in power down mode ¹ (Option 2) | | 2 | mAtypical |
| ICCPDM3 | Supply current in chip set power down mode | | 2 | mA |
| ICCBAT | Supply current in battery backup mode ¹ | | 50 | uA |
| PD | Power Dissipation - ICC max ³ | | 700 | mW |
| PDHL | Power Dissipation - ICCHL max ^{2 3} | | 850 | mW |

TABLE 9-1. DC CHARACTERISTICS

 1 Vin = VCC or GND, IO=0 mA 2 Includes DBx; IO=-5.0 mA source loads 3 Includes open drain high current drivers at Vol=0.4V



9.3 CRYSTAL CAPACITANCE

| SYMBOL | CHARACTERISTIC | MIN | МАХ | UNITS |
|---------------------|--------------------------------------|-----|--------|-------|
| | RTC CRYSTAL | | | |
| R1 | Crystal Motional Resistance | | 40 | K Ohm |
| CO | Crystal Shunt Capacitance | | 1.7 | pF |
| C1 | Crystal Motional Capacitance | | 0.0035 | pF |
| Q | Crystal Quality Factor | 50 | | к |
| Clin | Crystal Circuit Input Capacitance | 15 | ± 5% | pF |
| Cout | Crystal Circuit Output Capacitance | 15 | ± 5% | pF |
| RA | Crystal Circuit Drive Level Resistor | 422 | ± 1% | K Ohm |
| Rf | Crystal Circuit Feedback Resistor | 15 | 22 | M Ohm |
| | 16 MHZ CRYSTAL | | | |
| R _{series} | Crystal Circuit Resistors | 30 | | Ohm |
| Cshunt | Crystal Output | 10 | | pF |
| C ₁ | Crystal Input Capacitance | 47 | ± 5% | pF |
| C ₂ | Crystal Output Capacitance | 15 | ± 5% | pF |
| | 14 MHZ CRYSTAL | | | |
| Rseries | Crystal Circuit Resistors | 30 | | Ohm |
| Cshunt | Crystal Output | 10 | ± 5% | рF |
| C ₁ | Crystal Input Capacitance | 22 | ± 5% | рF |
| C ₂ | Crystal Output Capacitance | 22 | | pF |
| | | | | |
| | | | | |

TABLE 9-2. CRYSTAL CAPACITANCE

10.0 AC OPERATING CHARACTERISTICS

The AC Operating Characteristics are divided into four main categories:

- Floppy Disk Controller Specification
- Real Time Clock Specifications
- IDE Interface Timing
- Suspend/Resume Support Timing
- Chip Select Logic Decode Timing

Each table provides timing specifications which are followed by a figure displaying a timing diagram.

10.1 FLOPPY DISK CONTROLLER SPECIFICATIONS

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|----------|--|-----|---------------|-------|
| tCSS | CSL Input Address ¹ Set Up to IOR Low | 35 | | ns |
| pwRR | IOR Pulse Width | 180 | | ns |
| tCSH | CSL Input Address ¹ Hold Time from IOR High | 10 | | ns |
| tRD | Data Access Time from IOR Low | | 175 | ns |
| tDF | DB to Float Delay from IOR High | 10 | 80 | ns |
| tRI a | FIRQ Reset Delay Time from IOR High | | 1MCY + 150 | ns |

TABLE 10-1. FDC READ TIMING SPECIFICATION



FIGURE 10-1. FDC READ TIMING DIAGRAM

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|--|-----|-------|-------|
| tCSSA | CSL Input Address ¹ Set Up to BALE Low | 10 | | ns |
| tCSSH | CSL Input Address ¹ Hold Time from BALE Low | 5 | | ns |
| tCSS | CSL Input Address ¹ Set Up to IOR Low | 35 | | ns |
| pwRR | IOR Pulse Width | 180 | | ns |
| tRHAH | IOR High to BALE High | 10 | | ns |
| tRD | Data Access Time from IOR Low | | 175 | ns |
| tDF | DB(x) to Float Delay from IOR High | 10 | 80 | ns |
| tRI | FIRQ Reset Delay Time from IOR High | | 1 MCY | |
| | | | +150 | ns |
| | | | | |





FIGURE 10-2. FDC READ W/BALE TIMING DIAGRAM

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|--|-----|--------|-------|
| tCSS | CSL Input Address ¹ Set Up to IOW Low | 35 | | ns |
| pwWW | IOW Pulse Width | 180 | | ns |
| tCSH | CSL Input Address ¹ Hold Time from IOW High | 10 | | ns |
| tDW | Data Set Up Time to IOW High | 100 | | ns |
| tWD | Data Hold Time from IOW High | 10 | | ns |
| tWI | FIRQ Reset Delay from IOW High | | 1MCY + | |
| | | | 150 | ns |

TABLE 10-3. FDC WRITE TIMING SPECIFICATION



FIGURE 10-3. FDC WRITE TIMING DIAGRAM

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|--|-----|---------------|-------|
| tCSSA | CSL Input Address ¹ Set Up to BALE Low | 10 | | ns |
| tCSSH | CSL Input Address ¹ Hold Time from BALE Low | 5 | | ns |
| tCSS | CSL Input Address ¹ Set Up to IO Low | 35 | | ns |
| pwWW | IOW Pulse Width | 180 | | ns |
| tWHAH | IOW High to BALE High | 10 | | ns |
| tDW | Data Set Up Time to IOW High | 100 | | ns |
| tWD | Data Hold Time from IOW High | 10 | | ns |
| tWI | FIRQ Reset Delay from IOW High | | 1 MCY +150 | ns |
| | | 1 | | |

TABLE 10-4. FDC WRITE W/BALE TIMING SPECIFICATION



FIGURE 10-4. FDC WRITE W/BALE TIMING DIAGRAM

.

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|------------------------------------|-----|---|-------|
| tMCY | DMA Cycle Time | 52 | | MCY |
| tMA | DACK Delay Time from DMA High | 0 | | ns |
| tAM | DMA Reset Delay Time from DACK Low | | 140 | ns |
| tAA | DACK Width | 125 | | ns |
| tMRW | IOR or IOW Response from DMA High | | 48 | MCY |
| tMtMR | IOR Delay from DMA | 0 | | ns |
| tMW | IOW Delay from DMA | 0 | 1997 - 1997 - 1997 - 1997 - 1997 - 1997 - 1997 - 1997 - 1997 - 1997 - 1997 - 1997 - 1997 - 1997 - 1997 - 1997 - | ns |
| tRD | Data Access Time from IOR Low | | 120 | ns |
| tDW | Data Set Up Time to IOW High | 100 | | ns |
| tDF | DB to Float Delay from IOR High | 10 | 80 | ns |
| tWD | Data Hold Time from IOW High | 10 | | ns |

TABLE 10-5. FDC DMA TIMING SPECIFICATION



FIGURE 10-5. FDC DMA TIMING DIAGRAM

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|---|-----|-----|-------|
| tTCR | DACKEN, CSEN Delay from Last DMA or FIRQ, IOR | 0 | 192 | MCY |
| tTCW | DACKEN, CSEN Delay from Last DMA or FIRQ, IOW | 0 | 384 | MCY |
| tTC | DACKEN High, CSEN Low Pulse Width | 60 | | ns |
| tTCA | DACKEN High, CSEN Low to TC Asserted | 0 | 30 | ns |
| tTCD | DACKEN Low, CSEN High to TC De-Asserted | 0 | 30 | ns |

TABLE 10-6. FDC TERMINAL COUNT TIMING SPECIFICATION



FIGURE 10-6. FDC TERMINAL COUNT TIMING DIAGRAM

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|----------------------------|-----|-----|-------|
| tCY | Clock Period | 60 | | ns |
| tR | Clock Rise Time | | 5 | ns |
| tF | Clock Fall Time | | 5 | ns |
| tPH | Clock Active (High or Low) | 25 | | ns |





FIGURE 10-7. FDC 16 MHZ CLOCK TIMING DIAGRAM

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|-------------------------------|-----|-----|-------|
| tDST | DIRC Set Up to STEP Low | 4 | | MCY |
| tSTP | STEP Active Time Low | 24 | | MCY |
| tSTD | DIRC Hold Time from STEP High | 96 | | MCY |
| tSC | STEP Cycle Time | 132 | | MCY |
| tSTU | DS(x) Hold Time from STEP Low | 20 | | MCY |
| tIDX | IDX Index Pulse Width | 1 | | MCY |
| tRDD | RDD Active Time Low | 40 | | ns |
| tWDD | WD Write Data Width Low | 1/2 | | WCY |
| | | | | |

TABLE 10-8. FDC DISK DRIVE TIMING SPECIFICATION



FIGURE 10-8. FDC DISK DRIVE TIMING DIAGRAM

10.2 REAL TIME CLOCK SPECIFICATIONS

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|--|-----|-----|-------|
| tASD | Data C <u>vcle</u> IOW or IOR High to Address Cycle IOW Low (not shown) | 100 | | ns |
| tASED | Address Cycle IOW High to Data Cycle IOW or IOR Low (not shown) | 100 | | ns |
| tCSS | CSL Input Address ¹ Set Up to IOR Low | 35 | | ns |
| pwRS | IOR Pulse Width | 180 | | ns |
| tCSH | CSL Input Address ¹ Hold Time from IOR High | 10 | | ns |
| tDDR | Data Access Time from IOR Low | | 175 | ns |
| tDHR | DB to Float Delay from IOR High | 10 | 80 | ns |
| | | | | |

TABLE 10-9. RTC AND RAM READ TIMING SPECIFICATION



FIGURE 10-9. RTC AND RAM READ TIMING DIAGRAM

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|--|-----|-----|-------|
| tASD | Data C <u>ycle</u> IOW or IOR High to Address Cycle IOW Low (not shown) | 100 | | ns |
| tASED | Addre <u>ss Cycle IOW</u> High to Data Cycle IOW or IOR Low (not shown) | 100 | | ns |
| tCSSA | CSL Input Address ¹ Set Up to BALE Low | 10 | | ns |
| tcSSH | CSL Input Address ¹ Hold Time from BALE Low | 5 | | ns |
| tCSS | CSL Input Address ¹ Set Up to IOW Low | 35 | | ns |
| pwWW | IOW Pulse Width | 180 | | ns |
| tWHAH | IOW High to BALE High | 10 | | ns |
| tDSW | Address or Data Setup Time to IOW High | 100 | | ns |
| tDHW | Address or Data Hold Time from IOW High | 10 | | ns |
| | | | | |

TABLE 10-10. RTC AND RAM WRITE W/BALE TIMING SPECIFICATION



FIGURE 10-10. RTC AND RAM READ W/BALE TIMING DIAGRAM

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|--|-----|-----|-------|
| tASD | Data Cycle IOW or IOR High to Address Cycle IOW Low (not shown) | 100 | | ns |
| tASED | Address Cycle IOW High to Data Cycle IOW or IOR Low (not shown) | 100 | | ns |
| tCSS | CSL Input Address ¹ Set Up to IOW Low | 30 | | ns |
| pwWW | IOW Pulse Width | 180 | | ns |
| tCSH | CSL Input Address ¹ Hold Time from IOW High | 10 | | ns |
| tDSW | Address or Data Set Up Time to IOW High | 100 | | ns |
| tDHW | Address or Data Hold Time from IOW High | 10 | | ns |
| | | | | 1 |

TABLE 10-11. RTC AND RAM WRITE TIMING SPECIFICATION



FIGURE 10-11. RTC AND RAM WRITE TIMING DIAGRAM

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|--|-----|-----|-------|
| tASD | Data Cycle IOW or IOR High to Address Cycle IOW Low (not shown) | 100 | | ns |
| tASED | Address Cycle IOW High to Data Cycle IOW or IOR Low (not shown) | 100 | | ns |
| tCSSA | CSL Input Address ¹ Set Up to BALE Low | 10 | | ns |
| tcSSH | CSL Input Address ¹ Hold Time from BALE Low | 5 | | ns |
| tCSS | CSL Input Address ¹ Set Up to IO Low | 30 | | ns |
| pwRS | IOR Pulse Width | 180 | | ns |
| tRHAH | IOR High to BALE High | 10 | | ns |
| tDDR | Data Access Time from IOR Low | | 175 | ns |
| tDHR | DB(x) to Float Delay from IOR High | 10 | 80 | ns |
| | | | | |

TABLE 10-12. RTC AND RAM READ W/BALE TIMING SPECIFICATION



FIGURE 10-12. RTC AND RAM WRITE W/BALE TIMING DIAGRAM

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|---|-----|-----|-------|
| tRLIQ | RTCIRQ Release from IOR (Qualified by RECS) | | 2 | μS |
| tRLIH | RTCIRQ Release from RESET | | 2 | μS |
| | | | | |

TABLE 10-13. RTC IRQ RELEASE TIMING SPECIFICATION



| 200 | | ns |
|-----|---|-----|
| 5 | | μS |
| 32 | | MCY |
| | 5 | 5 |

TABLE 10-14. RESET TIMING SPECIFICATION



FIGURE 10-14. RESET TIMING DIAGRAM

10.3 IDE INTERFACE TIMING

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|---|-----|-----|-------|
| tCSA | CSL Input Valid to CSL Output Asserted | | 35 | ns |
| tCSD | CSL Input Invalid to CSL Output De-Asserted | | 35 | ns |
| tD7D | Propagation Delay from IDED7 to DB7 | | 20 | ns |
| tD7HR | DB7 to Float Delay from IOR High | 10 | 80 | ns |
| | | | | |

TABLE 10-15. IDE INTERFACE TIMING (IDED7 TO DB7)



FIGURE 10-15. IDE INTERFACE TIMING DIAGRAM (IDED7 TO 9B7)

1

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|--|-----|-----|-------|
| tCSSA | CSL Input Address ¹ Set Up to BALE Low | 10 | | ns |
| tCSSH | CSL Input Address ¹ Hold Time from BALE Low | 5 | | ns |
| tCSS | CSL Input Address ¹ Set Up to IO Low | 30 | | ns |
| tRHAH | IOR High to BALE High | 10 | | ns |
| tD7D | Propagation Delay from IDED7 to DB7 | | 20 | ns |
| tD7HR | DB7 to Float Delay from IOR High | 10 | 80 | ns |
| | | | | |

TABLE 10-16. IDE INTERFACE W/BALE TIMING (IDED7 TO DB7)



FIGURE 10-16. IDE INTERFACE W/BALE TIMING (IDED7 to DB7)

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|---|---------|-----|-------|
| tCSA | CSL Input Valid to CSL Output Asserted | | 35 | ns |
| tCSD | CSL Input Invalid to CSL Output De-Asserted | | 35 | ns |
| tIDDR | IDED7 Enable time from IOW low | | 60 | ns |
| tIDD | Propagation Delay from DB7 to IDED7 | | 60 | ns |
| tIDHR | IDED7 to Float Delay to IOW high | 20 | 160 | ns |
| | | · · · · | | |

TABLE 10-17. IDE INTERFACE TIMING (DB7 TO IDED7)



FIGURE 10-17. IDE INTERFACE TIMING (DB7 TO IDED7)

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|--|-----|-----|-------|
| tCSSA | CSL Input Address ¹ Set Up to BALE Low | 10 | | ns |
| tCSSH | CSL Input Address ¹ Hold Time From BALE Low | 5 | | ns |
| tCSS | CSL Input Address ¹ Set Up to IOW Low | 30 | | ns |
| tWHAH | IOW High to BALE High | 10 | | ns |
| tIDDR | IDED7 Enable time from IOW Low | | 60 | ns |
| tIDHR | IDED7 to Float Delay from IOW High | 20 | 160 | ns |
| | | | | |
| | | | | |

TABLE 10-18. IDE INTERFACE W/BALE TIMING (DB7 TO IDED7)



FIGURE 10-18. IDE INTERFACE W/BALE TIMING (DB7 to IDED7)

10.4 SUSPEND/RESUME TIMING

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|--------------------------------------|-----|-----|-------|
| tCWSS | CSL Input Valid and IOW Low to OSC | | | |
| | Transition to Low | 30 | 1.1 | ns |
| tCWSR | CSL Input Invalid and IOW Low to OSC | | | |
| | Transition to Low | 30 | | ns |
| tOSD | OSC Suspend Initiated to OSC Low Gap | 60 | | μS |
| tOSL | OSC Low Gap | 60 | | μS |
| | | | | |

TABLE 10-19. RESUME TO SUSPEND SUPPORT TIMING*

*Note: Code 15 can also be latched in with BALE.



FIGURE 10-19. RESUME TO SUSPEND SUPPORT TIMING

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|---------------|--|-----|-----|-------|
| tCRS | CSL Input Valid to OSC Transition to Low | 30 | | ns |
| tCRH | CSL Input Invalid to OSC Transition to Low | 30 | | ns |
| tCOR | CSL Output De-Assert to Resume WD76C30* | 60 | 91 | μS |
| tOTD | OSC Transition Delay (for XTAL warmup)* | 500 | 501 | ms |
| * CSL Code 16 | H is latched on the falling edge of OSC. | | | |





FIGURE 10-20. SUSPEND TO RESUME SUPPORT LOGIC

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|--------|--|-----|-----|-------|
| tCSA | CSL Input ² Valid to CSL Asserted | | 35 | ns |
| tCSD | CSL Input ² Invalid to CSL Output De-Asserted | | 35 | ns |
| tCSH | CSL Input Address ² Hold Time from IOW High | 10 | | ns |
| tWLPH | IOW Low to PCUW0/1 High | | 35 | ns |
| tWHPH | IOW High to PCUW0/1 Low | | 35 | ns |
| | | | | |





FIGURE 10-21. CHIP SELECT LOGIC DECODE TIMING DIAGRAM

| UNITS |
|-------|
| ns |
| ns |
| ns |
| |





FIGURE 10-22. CHIP SELECT LOGIC DECODE W/BALE TIMING DIAGRAM

Notes

¹ <u>The RTCALE and RTCCS</u> are internal to the WD76C20 and are used by the RTC during I/O operations. The CS, LDCR, and LDOR are also internal to the WD76C20 and used by the FDC during I/O operations. CSL Inputs de<u>coded</u> in Table 4-1 are comprised of DPH, DPL, RA10, RA9 and RA8. All CSL Input Addresses are qualified by the CSEN signal. The general specification for generating the internal and external signals is presented in Tables 10-21 and 10-22.

² CSL Inputs are decoded in Table 4-1 and are comprised of DPH, DPL, RA10, RA9 and RA8. All CSL Input Addresses are qualified by the CSEN signal as shown in Figure 10-21 and 10-22. Also included in this group is DACKEN which must be deasserted (logic=0) in order to allow the decoder to activate any signal other than TC, which is asserted (logic=1) when both DACKEN and CSEN are active.

³ CSL outputs are control lines used both int<u>ernally by the WD76C20 (FDCCS, FDC LDCR, FDC LDOR, RTC CS, and RTC AEN) and externally by other chips (IDEDENL, IDEDENH, CSIDE0, CSIDE1, CSSERA, CSSERB, CSPAR0, ROMOE, 8042CS, NPCS, PCUW0, PCUW1, PROGCS, EMS and TC). For all but one case, only a single, decoded output is asserted at any given time and is unique as decoded in Table 4-1. Although not mentioned in Table 4-1, TC is asserted when both DACKEN and CSEN are active, as specified in Table 10-6.</u>

11.0 PACKAGE DIMENSIONS

Figure 11-1 shows the 84-pin PLCC package dimension in inches and millimeters.



FIGURE 11-1. WD76C20 PACKAGE DIAGRAM (84-PIN PLCC)

Figure 11-2 shows the 84-pin PQFP package dimension in inches and millimeters.



FIGURE 11-2. WD76C20 PACKAGE DIAGRAM (84-PIN PQFP)

A.0 WD76C20LV DEVICE SPECIFICATIONS

A.1 INTRODUCTION

This appendix lists the specifications and describes the operation of the WD76C20LV. This appendix is only preliminary and may later be expanded into a separate document.

A.2 MAXIMUM RATINGS

Absolute maximum ratings; all voltages referenced to Vss.

| Storage Temperature | -65°C (-85°F)to 150°C (302°F) |
|---------------------|----------------------------------|
| Vcc | 4.5 volts |
| Voltage at any pin | -0.1 to 4.50 volts |
| Lithium Battery | 2.4 volts (nominal) |

| SYMBOL | CHARACTERISTIC | MIN | MAX | UNITS |
|---------|--|------|--------|-----------------------|
| VCC | + 3 V Supply | 3.0 | 3.6 | V |
| VBAT | Battery Backup Voltage | 2.4 | VDD | V |
| VIL | Input Low Voltage - Data Bus and XTOCS | -0.3 | 0.8 | V |
| VIH | Input High Voltage - Data Bus and XTOCS | 2.0 | VCC+.3 | V |
| VILT | Input Low Threshold - Schmitt Trigger | 0.8 | | Vtypical |
| VIHT | Input High Threshold - Schmitt Trigger | | 2.0 | Vtypical |
| VHYS | Schmitt Trigger Hysteresis | 0.5 | | V _{typical} |
| VOLAT | Output Low - DBus, FIRQ, DMA: IO=12mA | | 0.4 | V |
| VOHAT | Output High - DBus, FIRQ, DMA: IO=-5.0mA | 2.4 | | V |
| VOLHC | Output Low - Drive Interface: IO=48mA | | 0.4 | V |
| VOL | Output Low - All Others: IO=4mA | | 0.4 | V |
| VOH | Output High - All Others: IO=400µA | 2.4 | | V |
| ILUL | Latch Up Current Low | 40 | | mA |
| ILUH | Latch Up Current High | -40 | | mA |
| ILL | Leakage Current Low | | 10 | μA |
| ILH | Leakage Current High | | -10 | μA |
| ICC | Supply Current - 100µA source loads | | 50 | mA |
| ICC | Supply Current - 5mA source loads | | 100 | mA |
| ICCPDM1 | Supply Current in Power-Down Mode (Option 1) | | 100 | μA _{typical} |
| ICCPDM2 | Supply Current in Power-Down Mode (Option 2) | | 1 | mAtypical |
| ICCPDM3 | Supply Current in Chip Set Power-Down Mode | | 1 | mA |
| ICCBAT | Supply Current in Battery Backup Mode | | 25 | μA |
| PD | Power Dissipation - ICC max ¹ | | 300 | mW |
| PDHL | Power Dissipation - ICC max ^{2, 3} | | 350 | mW |

TABLE A-1. D.C. CHARACTERISTICS (WD76C20LV)

1 VIN = VCC or GND, IO = 0mA

2 Includes DBx: IO=-5.0 mA source loads

3 Includes open drain high current drivers at VOL = 0.3V





A.3 TIME BASE OSCILLATOR CIRCUIT

The oscillator that provides the time base for the RTC requires the external circuit shown in Figure A-1 and the values listed in Table A-2. The crystal used in parallel with the on-chip oscillator should be an AT-cut crystal with a 32.768 KHz resonant frequency as shown in Figure A-2, using signals listed in Table A-2. When in battery backup mode, this circuit is still active, providing the rest of the RTC with a valid time base.



FIGURE A-2. RTC CRYSTAL EXTERNAL CIRCUITRY



FIGURE A-3. RTC CRYSTAL PARAMETERS

5

A.4 POWER SWITCH

This functional block is used to detect when the system power is shutting down and the RTC needs to go into battery backup mode. In the event of a full chip power-down without a battery backup, the VRT bit of register D will be reset to zero, indicating that the contents of the SRAM and RTC operational registers are not guaranteed. In order to reset the bit, register D must be read after a full power-up.

A.5 BUS INTERFACE

The RTC Bus Interface block is used to access the internal bus for the WD76C20LV. Protocol is maintained between the BIL block (Bus Interface Logic) and the RTC Bus Interface. The BIL block generates the RD and WR strobes, and the CS signals are decoded from the external bus by the Chip Select Logic.

A.6 CLOCK DIVIDER

This functional block uses clock divider logic to split the 32.768 KHz time base down to a 1 Hz signal that can be used by the timekeeping blocks. It also provides the periodic interrupt block with access to all stages of the division.

A.7 CRYSTAL CAPACITANCE

| SYMBOL | CHARACTERISTICS | MIN | MAX | UNITS | | |
|---------|--------------------------------------|-----|--------|-------|--|--|
| | RTC CRYSTAL* | | | | | |
| R1 | Crystal Motional Resistance | | 40 | K ohm | | |
| CO | Crystal Shunt Capacitance | | 1.7 | pF | | |
| C1 | Crystal Motional Capacitance | | 0.0035 | pF | | |
| Q | Crystal Quality Factor | 50 | | ĸ | | |
| Clin | Crystal Circuit Input Capacitance | 30 | ±5% | pF | | |
| Солт | Crystal Output Capacitance | 30 | ±5% | pF | | |
| RA | Crystal Circuit Drive Level Resistor | 330 | ±1% | Kohm | | |
| RF | Crystal Circuit Feedback Resistor | 15 | 22 | M ohm | | |
| | 16 MHZ CRYST | AL | × | | | |
| Rseries | Crystal Circuit Resistors | 30 | | ohm | | |
| Cshunt | Crystal Output | 10 | | pF | | |
| C1 | Crystal Input Capacitance | 47 | ±5% | pF | | |
| C2 | Crystal Output Capacitance | 15 | ±5% | pF | | |
| | 14MHZ CRYSTAL | | | | | |
| Rseries | Crystal Circuit Resistors | 30 | | ohm | | |
| Cshunt | Crystal Output | 10 | ±5% | pF | | |
| C1 | Crystal Input Capacitance | 22 | ±5% | pF | | |
| C2 | Crystal Output Capacitance | 22 | | pF | | |

TABLE A-2. CRYSTAL CAPACITANCE FOR WD76C20LV

 * RTC crystal components specified are valid for crystals with A(CL) load capacitance of 18 pF typical. (CL = 18 pF).